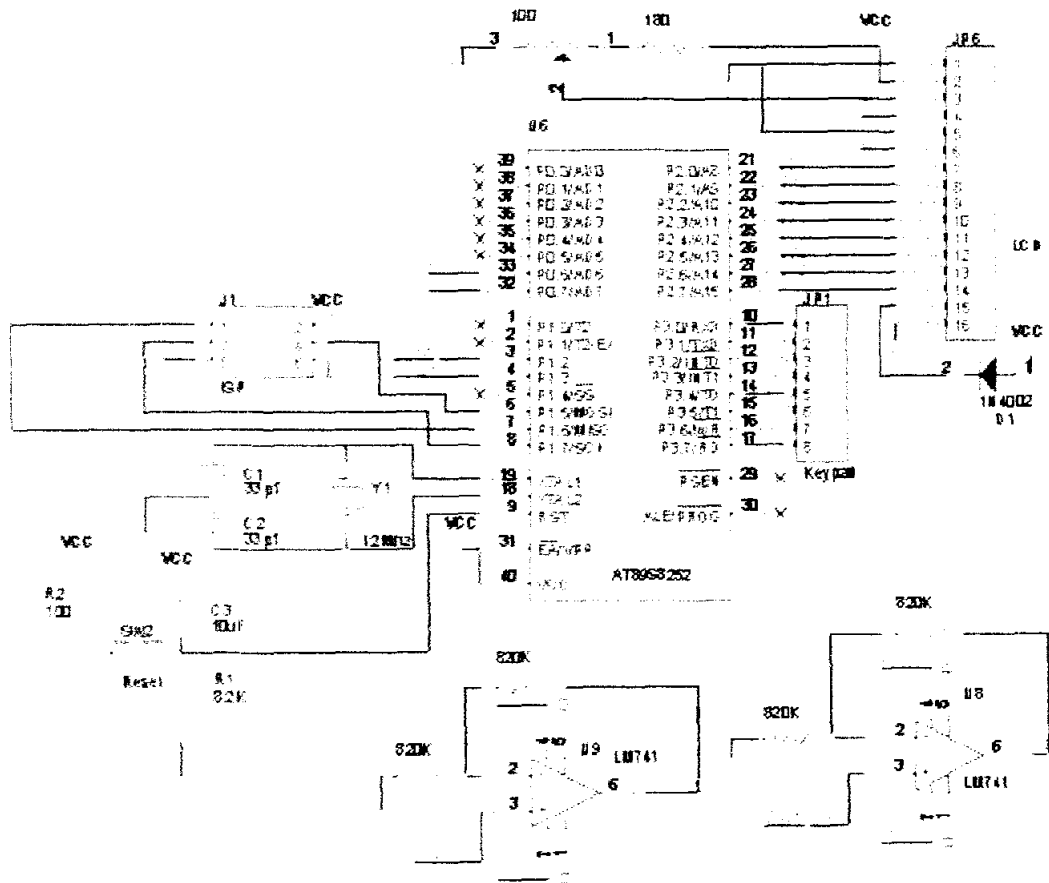
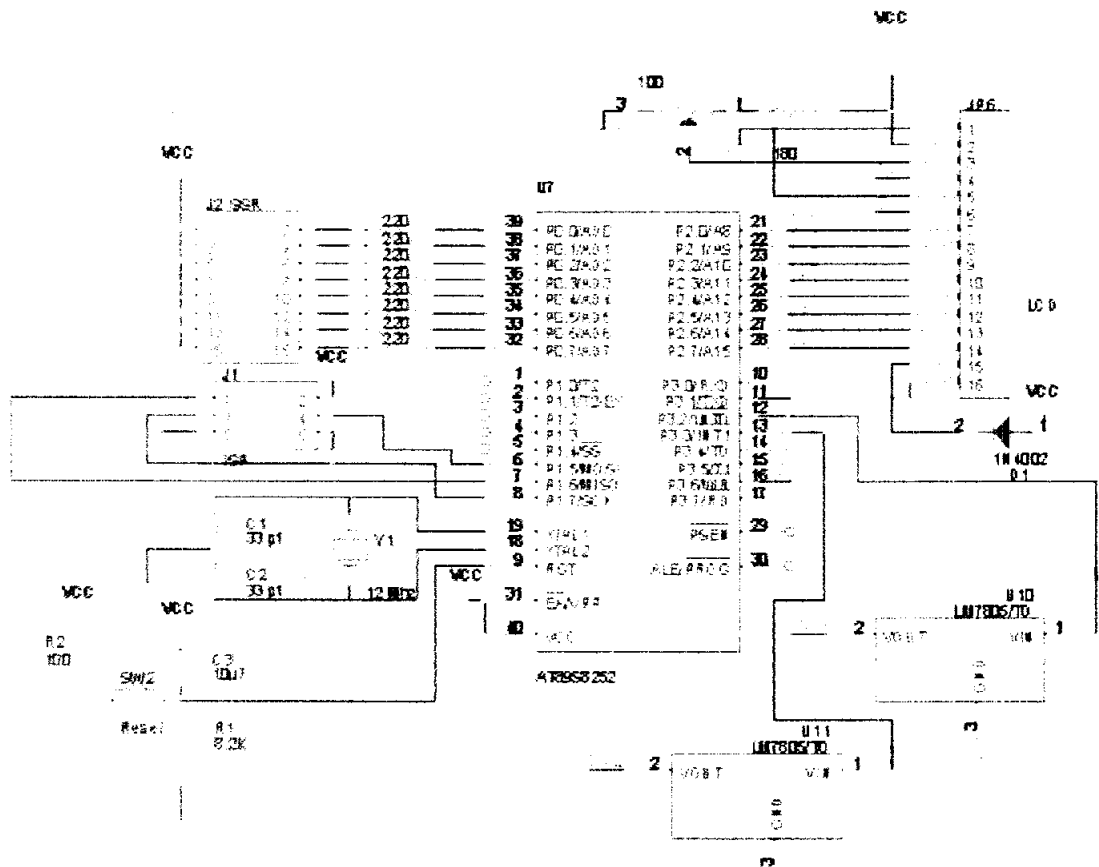


LAMPIRAN A

• Skema Pengirim



• Skema Penerima



LAMPIRAN B

```
#include<stdio.h>
#include<reg8252.h>

#define en P0_7 //en P0_7
#define rs P0_6 //rs P0_6
#define dataku P0
#define lcd_mem P2
#define clock P1_3
#define datanya P1_2 //P1_2 itu data

at 0x0 xdata unsigned char eeprom[56];
void tunda(unsigned char);
void init_lcd();
void clrscr();
void tulis(unsigned char,unsigned char,unsigned char,char);
unsigned char keypad(void);
void inisialisasi_serial();
void kirim_serial(unsigned char);
void tulis_eeprom(unsigned char,unsigned char);
void menu2(unsigned char);
void clock_serial(unsigned char);
void semua_penerima(unsigned char,unsigned char);

char code menu[67][20]={{"1.Masukkan inputan"}, {"2.Status Alat"}, {"3.Help"}, {"<<By Deathscythe>>"}, {"<<-Masukkan angka->>"}, {"Pnr(0-7),alat(0-8),"}, {"Status(0/1)"}, {"Pnr terlalu besar"}, {"Alat terlalu besar"}, {"Stat terlalu besar"}, {" " }, {"Pnr :"}}, {"Tekan tombol Can utk"}, {"keluar,panah atas"}, {"utk balik,panah ba-"}, {"wah utk lanjut."}, {"Digit pertama pada"}, {"menu pertama adalah"}, {"nomor penerima."}, {"Inputnya antara 0-7"}, {"Digit kedua pada "}, {"menu pertama adalah"}, {"nomor alat."}, {"Inputnya antara 0-8"}, {"Digit ketiga pada "}, {"menu pertama adalah"}, {"status alat."}, {"Inputnya hanya 0&1"}, {"Untuk mengontrol se-"}, {"mua penerima maka"}, {"digit pertama diisi"}, {"dengan 0"}, . {"Untuk mengontrol se"}, {"mua alat maka digit"}, {"kedua diisi 0"}, {"Berikut contohnya :"}, {"340=alat ke-4 pada"}, {"penerima ke-3 off"}, {"621=alat ke-2 pada"}, {"penerima ke-6 on"}, {"010=alat ke-1 pada"}, {"semua penerima off"}, {"051=alat ke-5 pada"}, {"semua penerima on"}, {"200=semua alat pada"}, {"penerima ke-2 off"}, {"701=semua alat pada"}, {"penerima ke-7 on"}, {"000=semua alat pada"}, {"setiap penerima off"}, {"001=semua alat pada"}, {"setiap penerima on"}, {"Status alat dapat di"}, {"lihat pada menu no-"}, {"2. Tombol yang di "}, {"pakai pada menu no"}, {"2 : panah atas utk "}, {"balik,panah bawah "}, {"utk lanjut,tombol"}, {"CAN utk keluar."}, {"< Create&Design By >"}, {"Chornelius Ariesta"}, {"NRP : 5103000066 "}, {"< Terima kasih =>"}, {"Penerima kosong !!"}, {"Alat kosong !!"}, {"status kosong !!"}};

/*=====
|                                     |
|                               Program Utama                               |
|                                     |
|=====*/

void main(void)
{
    unsigned char posisi_y;
    init_lcd(); //Inisialisasi LCD
```

```

tulis(0,1,2,0);           //Tampilkan Menu Pertama
tulis(1,2,2,0);           //Tampilkan Menu Kedua
tulis(2,3,2,0);           //Tampilkan Menu Ketiga
tulis(3,4,0,0);
posisi_y=1;
tulis(0,posisi_y,0,'=');   //Tampilkan Posisi Panah
tulis(1,posisi_y,1,'>');   //Tampilkan Posisi Panah =>
while(1)
{
    switch(keypad())        //Cek Keypad apakah ada tom bol yg ditekan
    {
        case 'u':          //Tombol Panah Atas ditekan
            tulis(0,posisi_y,0,' ');
            tulis(1,posisi_y,1,' ');
            posisi_y--;
            if (posisi_y==0)posisi_y=1;
            tulis(0,posisi_y,0,'=');
            tulis(1,posisi_y,1,'>');
            tunda(4);
            break;

        case 'd':          //Tombol Panah bawah ditekan
            tulis(0,posisi_y,0,' ');
            tulis(1,posisi_y,1,' ');
            posisi_y++;
            if (posisi_y==4)posisi_y=3;
            tulis(0,posisi_y,0,'=');
            tulis(1,posisi_y,1,'>');
            tunda(4);
            break;

        case 'e':tunda(4);  //Tombol ENT ditekan
            tunda(4);
            menu2(posisi_y);
            clrscr();
            tulis(0,1,2,0);
            tulis(1,2,2,0);
            tulis(2,3,2,0);
            tulis(3,4,0,0);
            tulis(0,posisi_y,0,'=');
            tulis(1,posisi_y,1,'>');
            break;
    }
}
}

```

```

/*=====
|                                     |
|                               Prosedur untuk menulis kalimat pada LCD |
|                                     |
|=====*/

```

```

void tulis(unsigned char no_kal, unsigned char pos_Y, unsigned char pos_X, char karakter)
{
    unsigned char letak_mem;
    unsigned char y;
    switch(pos_Y)
    {
        case 1: letak_mem=0x80; //Untuk meletakkan kursor pada baris 1
                break;
        case 2: letak_mem=0xC0; //Untuk meletakkan kursor pada baris 2
                break;
        case 3: letak_mem=0x94; //Untuk meletakkan kursor pada baris 3
                break;
        case 4: letak_mem=0xD4; //Untuk meletakkan kursor pada baris 4
                break;
    }

    letak_mem=letak_mem+pos_X;
    rs=0;
    lcd_mem=letak_mem;
    en=1;
    en=0;
    tunda(1);
    rs=1;
    if (karakter!=0) {lcd_mem=karakter; en=1; en=0; tunda(2);}
    else
    {
        for (y=0; menu[no_kal][y]; y++){ lcd_mem=menu[no_kal][y]; //untuk menulis
kalimat/karakter pada LCD
        en=1;
        en=0;
        tunda(2);}
    }
}

```

```

/*=====
|                                     |
|                               Prosedur untuk Inisialisasi LCD |
|                                     |
|=====*/

```

```

void init_lcd()
{
    rs=0;
    lcd_mem=0x38;
    en=1;
    en=0;
}

```

```
tunda(1);
```

```
rs=0;
```

```
lcd_mem=0x38;
```

```
en=1;
```

```
en=0;
```

```
tunda(1);
```

```
rs=0;
```

```
lcd_mem=0x38;
```

```
en=1;
```

```
en=0;
```

```
tunda(1);
```

```
rs=0;
```

```
lcd_mem=0x38;
```

```
en=1;
```

```
en=0;
```

```
tunda(1);
```

```
lcd_mem=0x06;
```

```
en=1;
```

```
en=0;
```

```
tunda(1);
```

```
lcd_mem=0x0C;
```

```
en=1;
```

```
en=0;
```

```
tunda(1);
```

```
lcd_mem=0x01;
```

```
en=1;
```

```
en=0;
```

```
tunda(1);
```

```
}
```

```
/*=====
|               Prosedur untuk menghapus tampilan LCD               |
|=====*/
```

```
void clrscr()
```

```
{ rs=0;
```

```
  lcd_mem=0x01;
```

```
  en=1;
```

```
  en=0;
```

```
  tunda(1);
```

```
}
```

```

/*-----
|                                     |
|                               Prosedur Delay untuk LCD, Clock Serial & Keypad |
|                                     |
|-----*/

```

```

void tunda(unsigned char nilai)
{
    unsigned char X;
    switch(nilai)
    {
        case 1: TMOD=0x21;
                TH0=0xC5;           //DELAY 20 ms untuk Init LCD
                TL0=0x67;
                TR0=1;
                TF0=0;
                while (TF0==0);
                break;
        case 2: TMOD=0x21;
                TH0=0xFF;           //delay 30 us untuk jeda tulisan
                TL0=0xCD;
                TR0=1;
                TF0=0;
                while (TF0==0);
                break;
        case 3: TH2=0xF8;           //delay 2 ms untuk clock serialku
                TL2=0x30;
                TF2=0;
                TR2=1;
                while (TF2==0);
                break;
        case 4: X=0;
                do
                {
                    TH0=0x3C;       //delay 150 ms untuk debounce
                    TL0=0xAF;
                    TMOD=0x21;
                    TR0=1;
                    TF0=0;
                    while (TF0==0);
                    X++;
                }
                while(X!=3);
                break;
    }
}

```

Fungsi untuk menerima masukan dari keypad

```
{unsigned char perulangan,tombol,cek_baris[4]={0x7F,0xBF,0xDF,0xEF};
```

do {

```
switch(P3)
```

```
case 0x77:    tombol='1';    //Angka 1
              break;
```

```
case 0x7B:    tombol='2';    //Angka 2
              break;
```

```
case 0x7D:    tombol='3';    //Angka 3
              break;
```

```
case 0x7E:    tombol='c';    //tombol Cor
break;
```

```
case 0xB7:    tombol='4';    //Angka 4
              break;
```

```
case 0xBB:    tombol='5';    //Angka 5
              break;
```

```
case 0xBD:    tombol='6';    //Angka 6
              break;
```

```
case 0xBE:   tombol='m';    //tombol Men0
break;
```

```
case 0xD7:    tombol='7';    //Angka 7
              break;
```

```
case 0xDB:    tombol='8';    //Angka 8
              break;
```

```
case 0xDD:    tombol='9';    //Angka 9
              break;
```

```
case 0xDE:   tombol='u';    //tombol panah atas
            break;
```

```
case 0xE7:    tombol='C';    //tombol Can
break;
```

```
case 0xEB:    tombol='0';    //Angka 0
              break;
```

```
case 0xED:    tombol='e';    //tombol Ent
              break;
```

```
case 0xEE:   tombol='d';    //tombol panah bawah
            break;
```

```
default:      tombol=0;
```

```
if (perulangan==4)perulangan=0;
```

```

    }
    while (tombol==0);
    return(tombol);
}

```

```

void inisialisasi_serial()
{
    SCON=0x40;
    TMOD=0x21;
    TH1=0xF4; //Baudrate 2400
    TF1=0;
    TR1=1;
}

```

```

/*=====
|                                     |
|                               Prosedur untuk menulis data pada EEPROM internal                               |
|                                     |
|=====*/

```

```

void tulis_eeprom(unsigned char no_data, unsigned char data_eeprom)
{ unsigned char bandingkan;
    WMCON=0x1A;
    eeprom[no_data]=data_eeprom;
    do
    {
        bandingkan=WMCON & 0x02;}
    while (bandingkan==0);
    WMCON=0x0A;
}

```

```

/*=====
|                                     |
|                               Prosedur Menu                               |
|                                     |
|=====*/

```

```

void menu2 (unsigned char no_menu)
{ struct kirim_data
    {
        unsigned alat0      : 1;
        unsigned alat1      : 1;
        unsigned alat2      : 1;
        unsigned alat3      : 1;
        unsigned status_bit  : 1;
        unsigned bit_penerima0: 1;
        unsigned bit_penerima1: 1;
        unsigned bit_penerima2: 1;
    };
    union
    {

```

```

        unsigned char byte_data;
        struct kirim_data byte;
    } bit_data;

```

```

unsigned char tomb_pos, alamat_eeprom, nel, check, baris_tulisan, counter;
unsigned char quit, awal_help;
unsigned char dataku[5];
switch(no_menu)
{

```

```

    case 1: dataku[1]=0;
            dataku[2]=0;
            dataku[3]=0;
            clrscr();
            tulis(4,1,0,0);
            tulis(5,3,0,0);
            tulis(6,4,0,0);
            tomb_pos=5;
            do
            { quit='0';
              switch(keypad())
              {
                  case 'u':break;
                  case 'd':break;
                  case 'm':break;
                  case 'c':
                      tulis(0,2,tomb_pos,' ');
                      tomb_pos--;
                      if (tomb_pos==4) tomb_pos=5;
                      break;

```

```

                  case 'C':quit='1';
                      break;

```

case 'e':dataku[1]=dataku[1]-48; //untuk merubah ASCII nomor penerima menjadi bilangan desimal

dataku[2]=dataku[2]-48; //untuk merubah ASCII nomor alat menjadi bilangan desimal

dataku[3]=dataku[3]-48; //untuk merubah ASCII status alat menjadi bilangan desimal

if (dataku[1]==0xD0) //apabila penerima tidak diisi sama sekali maka dataku[1] akan bernilai 256-48= 208

tulis(64,2,0,0); //tampilkan pesan bahwa penerima belum diisi, tunda selama beberapa detik

```

        nel=0;
        do
        {
            tunda(4);
            nel++;
        }
        while(nel!=10);

```

```

        tulis(10,2,0,0);    //untuk menghapus baris 2
        tomb_pos=5;
        tulis(0,2,tomb_pos,' ');
        dataku[1]=0;
        dataku[2]=0;
        dataku[3]=0;
        break;
    }
    if (dataku[2]==0xD0)    //apabila alat tidak diisi
sama sekali maka dataku[1] akan bernilai 256-48= 208
    {        tulis(65,2,0,0);    //tampilkan pesan bahwa
penerima belum diisi, tunda selama beberapa detik
        nel=0;
        do
        {
            tunda(4);
            nel++;
        }
        while(nel!=10);
        tulis(10,2,0,0);    //untuk menghapus baris 2
        tomb_pos=5;
        tulis(0,2,tomb_pos,' ');
        dataku[1]=0;
        dataku[2]=0;
        dataku[3]=0;
        break;
    }
    if (dataku[3]==0xD0)    //apabila status tidak diisi
sama sekali maka dataku[1] akan bernilai 256-48= 208
        tulis(66,2,0,0);    //tampilkan pesan bahwa penerima
belum diisi, tunda selama beberapa detik
        nel=0;
        do
        {
            tunda(4);
            nel++;
        }
        while(nel!=10);
        tulis(10,2,0,0);    //untuk menghapus baris 2
        tomb_pos=5;
        tulis(0,2,tomb_pos,' ');
        dataku[1]=0;
        dataku[2]=0;
        dataku[3]=0;
        break;
    }
    if (dataku[1]>7)    //cek apakah penerima lebih dari 7
    {        tulis(7,2,0,0);    //tampilkan pesan kesalahan
        nel=0;

```

	do	
	{	
	tunda(4);	
	nel++;	
	}	
	while(nel!=10);	
	tulis(10,2,0,0);	//untuk menghapus baris 2
	tomb_pos=5;	
	tulis(0,2,tomb_pos,'');	
	dataku[1]=0;	
	dataku[2]=0;	
	dataku[3]=0;	
	break;	
	}	
apakah alat lebih dari 8	if (dataku[2]>8)	//cek
kesalahan	{ tulis(8,2,0,0);	//tampilkan pesan
	nel=0;	
	do	
	{	
	tunda(4);	
	nel++;	
	}	
	while(nel!=10);	
	tulis(10,2,0,0);	
	tomb_pos=5;	
	tulis(0,2,tomb_pos,'');	
	dataku[1]=0;	
	dataku[2]=0;	
	dataku[3]=0;	
	break;	
	}	
apakah status lebih dari 1	if (dataku[3]>1)	//cek
kesalahan	{ tulis(9,2,0,0);	//tampilkan pesan
	nel=0;	
	do	
	{	
	tunda(4);	
	nel++;	
	}	
	while(nel!=10);	
	tulis(10,2,0,0);	
	tomb_pos=5;	
	tulis(0,2,tomb_pos,'');	
	dataku[1]=0;	
	dataku[2]=0;	

```

        dataku[3]=0;
        break;
    }
    dataku[4]=(dataku[1]<<5)+(dataku[3]<<4)+(dataku[2]);
    bit_data.byte_data=dataku[4];
    if (dataku[1]==0) semua_penerima(dataku[2],dataku[3]+48);
//cek apakah penerima=0
    else if (dataku[2]==0) //cek apakah alat=0
    {
        nel=0;
        do
        {
            nel++;
            alamat_eeprom=((dataku[1]*8)+nel);
            tulis_eeprom(alamat_eeprom,(dataku[3]+48));
        }
        while (nel!=8);
    }
    else
    {
        alamat_eeprom=((dataku[1]*8)+dataku[2]);
        tulis_eeprom(alamat_eeprom,(dataku[3]+48));
    }
    quit='1';
    break;
    default: tomb_pos++;
    if (tomb_pos==9)tomb_pos=8;
    dataku[tomb_pos-5]=keypad();
    tulis(0,2,tomb_pos,dataku[tomb_pos-5]);
    quit='0';
    break;
}
tunda(4);
}
while (quit!='1');
break;

case 2: clrscr();
        baris_tulisan=1;
        nel=8;
        check=1;
        counter=0;
        do
        { tulis(11,baris_tulisan,0,0); //tampilkan kata "Pnr : "
pada baris pertama pada LCD
            tulis(11,baris_tulisan,4,'0'+baris_tulisan); //tampilkan angka
"1" pada baris pertama kolom ke empat, sehingga pada LCD tampil tulisan "Pnr 1 : "
            do
            { nel++;
                counter++;
                WMCON=0x0A;
                tulis(0,baris_tulisan,nel-check,eeprom[nel]);

```

```

    }
    while (counter!=8);
    baris_tulisan++;
    check=check+8;
    counter=0;
    }
    while (baris_tulisan!=5);
    do
    {
    switch(keypad())
    {
    case 'u':
        baris_tulisan=1;
        nel=8;
        check=1;
        counter=0;
        do
        { tulis(11,baris_tulisan,0,0);          //tampilkan kata
        "Pnr : " pada baris pertama pada LCD
        tulis(11,baris_tulisan,4,'0'+baris_tulisan);          //tampilkan
        angka "1" pada baris pertama kolom ke empat, sehingga pada LCD tampil tulisan "Pnr 1 : "
        do
        { nel++;
        counter++;
        WMCON=0x0A;
        tulis(0,baris_tulisan,nel-check,eeprom[nel]);
        }
        while (counter!=8);
        baris_tulisan++;
        check=check+8;
        counter=0;
        }
        while (baris_tulisan!=5);
        break;
        case 'd':
        clrscr();
        baris_tulisan=1;
        nel=40;
        check=33;
        counter=0;
        do
        { tulis(11,baris_tulisan,0,0);          //tampilkan kata
        "Pnr : " pada baris pertama pada LCD
        tulis(11,baris_tulisan,4,'4'+baris_tulisan);          //tampilkan
        angka "1" pada baris pertama kolom ke empat, sehingga pada LCD tampil tulisan "Pnr 1 : "
        do
        { nel++;
        counter++;
        WMCON=0x0A;

```

```

}
/*=====
|
|                               Prosedur serial
|
|=====*/

```

```

void clock_serial(unsigned char xx)
{
    datanya=xx;
    clock=0;
    tunda(3);
    clock=1;
    tunda(3);
}

```

```

void semua_penerima(unsigned char alamat_alat, unsigned char isi_data)
{
    unsigned char perulangan_1, alamat_penerima, perulangan_2;
    perulangan_1=0;
    do
    {
        perulangan_1++;
        if (alamat_alat==0)
        {
            perulangan_2=0;
            do
            {
                perulangan_2++;
                alamat_penerima=(perulangan_1*8)+perulangan_2;
                tulis_eeprom(alamat_penerima, isi_data);
            }
            while(perulangan_2!=8);
        }
        else
        {
            alamat_penerima=(perulangan_1*8)+alamat_alat;
            tulis_eeprom(alamat_penerima, isi_data);
        }
    }
    while(perulangan_1!=7);
}

```

```

void kirim_serial(unsigned char ser)
{
    SBUF=ser;
    while(TI==0);
    TI=0;
}

```

```

}
/*=====
Prosedur serial
=====*/

void clock_serial(unsigned char xx)
{ datanya=xx;
  clock=0;
  tunda(3);
  clock=1;
  tunda(3);
}

void semua_penerima(unsigned char alamat_alat, unsigned char isi_data)
{ unsigned char perulangan_1, alamat_penerima, perulangan_2;
  perulangan_1=0;
  do
  { perulangan_1++;
    if (alamat_alat==0)
    { perulangan_2=0;
      do
      { perulangan_2++;
        alamat_penerima=(perulangan_1*8)+perulangan_2;
        tulis_eeprom(alamat_penerima, isi_data);
      }
      while(perulangan_2!=8);
    }
    else
    { alamat_penerima=(perulangan_1*8)+alamat_alat;
      tulis_eeprom(alamat_penerima, isi_data);
    }
  }
  while(perulangan_1!=7);
}

void kirim_serial(unsigned char ser)
{ SBUF=ser;
  while(TI==0);
  TI=0;
}

```

LAMPIRAN C

\$include(reg8252.inc)

```
rs          bit p1.0
en          bit p1.1
status      bit 04h
buffer_serial equ 20h
valid       equ 40h
buffer      equ 57h
dataku      equ 40h
temp        equ 59h
jumlah_lcd  equ 50h
jumlah      equ 51h
hasil       equ 62h
```

```
org 0h
sjmp start
```

```
org 03h
ljmp terima_data
```

```
org 2Bh
ljmp cek_valid
```

```
org 30h
start:      mov r2,#0
            mov ie,#0a1h      ;set enable interrupt (int external 0 dan timer 2 int)
            setb pt2          ;set supaya int timer 1 menjadi high
            setb it0          ;set supaya interrupt xternal 0 aktifnya negatif edge triggering
            acall init_lcd
            mov dptr,#penerima
            acall tulis_kalimat
```

```
start1:     acall cek_isi_eeprom ;Panggil prosedur utk cek isi eeprom
            ;acall detik
            sjmp start1         ;Loncat ke program utama
```

```
terima_data: push acc           ;simpan accumulator ke stack memori
            mov a,buffer_serial
            cjne r2,#0,data_ke_n ;cek cek jumlah bit data yang diterima
            acall waktu_kirim
```

```
data_ke_n:  jnb p3.3,data_nol
            setb acc.7
            sjmp selesai_terima
```

```
data_nol:   clr acc.7
selesai_terima: rl a
            mov buffer_serial,a
            inc r2
```

```

sel:      pop acc                ;ambil isi accumulator dari stack memori
          reti

cek_valid: push acc
          cjne r2,#8,tidak_valid ;cek apakah jumlah data yang diterima=8bit
          acall decoder

tidak_valid: mov r2,#0
            mov buffer_serial,#0 ;kosongkan isi buffr serial
            clr tr2
            clr tf2
            pop acc                ;ambil isi accumulator dari stack memori
            reti

decoder:   mov a,buffer_serial
          anl a,#11100000b
          cjne a,#20h,decoder_selesai ;cek apakah data yang diterima untuk
penerima pertama?
          jnb status,status_off        ;cek apakah status alat on/off
          mov dataku,#10h              ;alat diset on
          sjmp cek_alamat

status_off: mov dataku,#0              ;alat diset off
cek_alamat: mov a,dataku
          anl a,#10h                  ;ambil bit status alat
          mov r5,a                    ;bit status disimpan di r5
          mov a,buffer_serial         ;isi accumulator dengan buffer serial
          anl a,#0fh                  ;ambil bit nomor alat
          mov hasil,a                 ;simpan bit nomor alat pada variable hasil
          mov r4,a
          acall switch_on_off
          mov dptr,#0
          mov dpl,hasil
          acall tulis_eeprom          ;panggil prosedur untuk menulis eeprom
          mov r0,#06h

decoder_selesai:reti

switch_on_off: cjne r4,#1,dua          ;prosedur untuk menyalakan
              cjne r5,#10h,satu_off
              setb p0.0
              sjmp dua

satu_off:   clr p0.0

dua:        cjne r4,#2,tiga
              cjne r5,#10h,dua_off
              setb p0.1
              sjmp tiga

dua_off:    clr p0.1
tiga:      cjne r4,#3,empat
              cjne r5,#10h,tiga_off
              setb p0.2

```

```

    sjmp empat
tiga_off:  clr p0.2
empat:    cjne r4,#4,lima
          cjne r5,#10h,empat_off
          setb p0.3
          sjmp lima
empat_off: clr p0.3
lima:     cjne r4,#5,enam
          cjne r5,#10h,lima_off
          setb p0.4
          sjmp enam
lima_off: clr p0.4
enam:     cjne r4,#6,tujuh
          cjne r5,#10h,enam_off
          setb p0.5
          sjmp tujuh
enam_off: clr p0.5
tujuh:    cjne r4,#7,delapan
          cjne r5,#10h,tujuh_off
          setb p0.6
          sjmp delapan
tujuh_off: clr p0.6

delapan:  cjne r4,#8,switch_selesai
          cjne r5,#10h,delapan_off
          setb p0.7
          sjmp switch_selesai
delapan_off: clr p0.7
switch_selesai: nop
            ret

waktu_kirim:  clr C_T2                ;prosedur timer untuk menerima data
              setb CP_RL2
              ;mov t2con,#01h
              mov th2,#83h
              mov tl2,#00h
              setb tr2
              clr tf2
              ret

cek_isi_EEPROM:  mov jumlah_lcd,#1'    ;prosedur untuk memeriksa isi EEPROM
                                                         dan menyalakan alat.
              mov jumlah,#1
              mov buffer,#0c0h
              acall fungsi_init
              mov dptr,#alat_nomer
              acall tulis_kalimat

cek_isi_eeprom2:  mov buffer,#0c5h

```

```

        acall fungsi_init
        mov buffer,jumlah_lcd
        acall fungsi_tulis
        mov dptr,#0h
        mov dpl,jumlah
        acall baca_eeprom
        jb acc.4,switch_on
        mov buffer,#0c9h
        acall fungsi_init
        mov dptr,#mati
        acall tulis_kalimat
;
switch_on:
        mov buffer,#0c9h
        acall fungsi_init
        mov dptr,#hidup
        acall tulis_kalimat
belum_selesai:
        mov dptr,#0h
        mov dpl,jumlah
        acall baca_eeprom
        mov a,dataku
        anl a,#10h
        mov r5,a
        mov r4,jumlah
        acall switch_on_off
        acall detik
        inc jumlah_lcd
        inc jumlah
        mov r4,jumlah
        cjne r4,#9,cek_isi_eeprom2
cek_isi_selesai:
        ret

tulis_EEPROM:
        mov wmcon,#1Ah      ;prosedur untuk mengisi EEPROM
        mov a,dataku
        movx @dptr,a
cek_busy:
        mov a,wmcon
        anl a,#02h
        jz cek_busy
        mov wmcon,#0ah
        ret

baca_EEPROM:
        mov wmcon,#0aH      ;prosedur untuk membaca isi EEPROM
        movx a,@dptr
        mov dataku,a
        ret

tulis_kalimat:
        clr a                ;prosedur untuk menulis kata pada LCD
        move a,@a+dptr
        cjne a,#0fh,ngga_sama

```

```

ngga_sama:      sjmp selesai
                 acall write_text
                 inc dptr
                 sjmp tulis_kalimat
selesai:        ret

detik:          tunda11 50000,20,11h
                 ret

;-----
; Clear LCD Screen
;-----
clrscr:         mov buffer,#01h
                 acall fungsi_init
                 ret

;-----
; Write Text
;-----
write_text:     mov     buffer,a
                 acall  fungsi_tulis
                 ret

;-----
; Inisialisasi LCD
;-----
init_led:      acall  wait_led
                 mov   buffer,#038H
                 acall  fungsi_init

                 mov   buffer,#06H
                 acall  fungsi_init

                 mov   buffer,#0CH
                 acall  fungsi_init

                 mov   buffer,#01H
                 acall  fungsi_init
                 ret

;-----
; Fungsi Init
;-----
fungsi_init:   mov p2,buffer
                 clr   rs
                 setb  cn
                 clr  en
                 acall wait_led
                 ret

```

```
;-----  
; Fungsi Tulis  
;-----
```

```
fungsi_tulis:    mov p2,buffer  
                 setb    rs  
                 setb    en  
                 clr     en  
                 acall wait_tulis  
                 ret
```

```
;-----  
; Wait LCD  
;-----
```

```
wait_lcd:        mov     tmod,#01H  
                 mov     th0,#0C8H  
                 mov     tl0,#08H  
                 clr     tf0  
                 setb    tr0  
                 jnb     tf0,$  
                 ret
```

```
wait_tulis:      mov r6,#100  
                 djnz r6,$  
                 ret
```

```
status_alat:     db 'Status :      ',0Fh  
hidup:           db 'Hidup',0Fh  
mati:            db 'Mati ',0Fh  
Penerima:        db 'Penerima 1   ',0Fh  
alat_nomer:      db 'Alat   :    ',0Fh
```

```
end
```

LAMPIRAN D

Features

- Compatible with MCS-51™ Products
- 8K Bytes of In-System Reprogrammable Downloadable Flash Memory
 - SPI Serial Interface for Program Downloading
 - Endurance: 1,000 Write/Erase Cycles
- 1K Bytes EEPROM
 - Endurance: 100,000 Write/Erase Cycles
- 1V to 6V Operating Range
- Full Static Operation: 0 Hz to 24 MHz
- Three-level Program Memory Lock
- 64 x 8-bit Internal RAM
- 32 Programmable I/O Lines
- Three 16-bit Timer/Counters
- Six Interrupt Sources
- Programmable UART Serial Channel
- PI Serial Interface
- Low-power Idle and Power-down Modes
- Interrupt Recovery From Power-down
- Programmable Watchdog Timer
- Dual Data Pointer
- Power-off Flag

Description

The AT89S8252 is a low-power, high-performance CMOS 8-bit microcomputer with 8K bytes of downloadable Flash programmable and erasable read only memory and 1K bytes of EEPROM. The device is manufactured using Atmel's high-density nonvolatile memory technology and is compatible with the industry-standard 80C51 instruction set and pinout. The on-chip downloadable Flash allows the program memory to be reprogrammed in-system through an SPI serial interface or by a conventional nonvolatile memory programmer. By combining a versatile 8-bit CPU with downloadable Flash on a monolithic chip, the Atmel AT89S8252 is a powerful microcomputer which provides a highly-flexible and cost-effective solution to many embedded control applications.

The AT89S8252 provides the following standard features: 8K bytes of downloadable Flash, 2K bytes of EEPROM, 256 bytes of RAM, 32 I/O lines, programmable watchdog timer, two data pointers, three 16-bit timer/counters, a six-vector two-level interrupt architecture, a full duplex serial port, on-chip oscillator, and clock circuitry. In addition, the AT89S8252 is designed with static logic for operation down to zero frequency and supports two software selectable power saving modes. The Idle Mode stops the CPU while allowing the RAM, timer/counters, serial port, and interrupt system to continue functioning. The Power-down mode saves the RAM contents but freezes the oscillator, disabling all other chip functions until the next interrupt or hardware reset.

The downloadable Flash can be changed a single byte at a time and is accessible through the SPI serial interface. Holding RESET active forces the SPI bus into a serial programming interface and allows the program memory to be written to or read from. Access Lock Bit 2 has been activated.



8-bit Microcontroller with 8K Bytes Flash

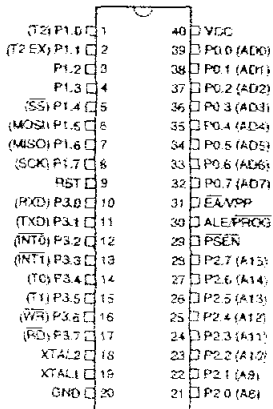
AT89S8252



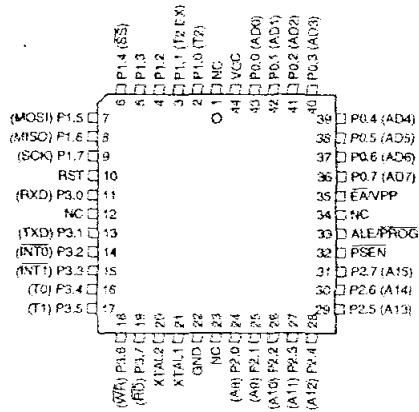


Pin Configurations

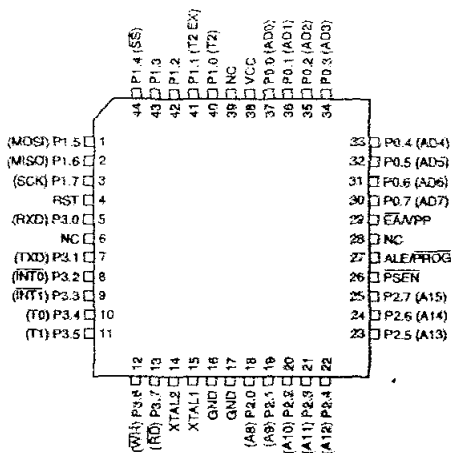
PDIP



PLCC



PQFP/TQFP



Pin Description

Port 0
Supply voltage.

Port 0
Ground.

Port 0 is an 8-bit open drain bi-directional I/O port. As an output port, each pin can sink eight TTL inputs. When 1s are written to port 0 pins, the pins can be used as high-impedance inputs.

Port 0 can also be configured to be the multiplexed low-order address/data bus during accesses to external

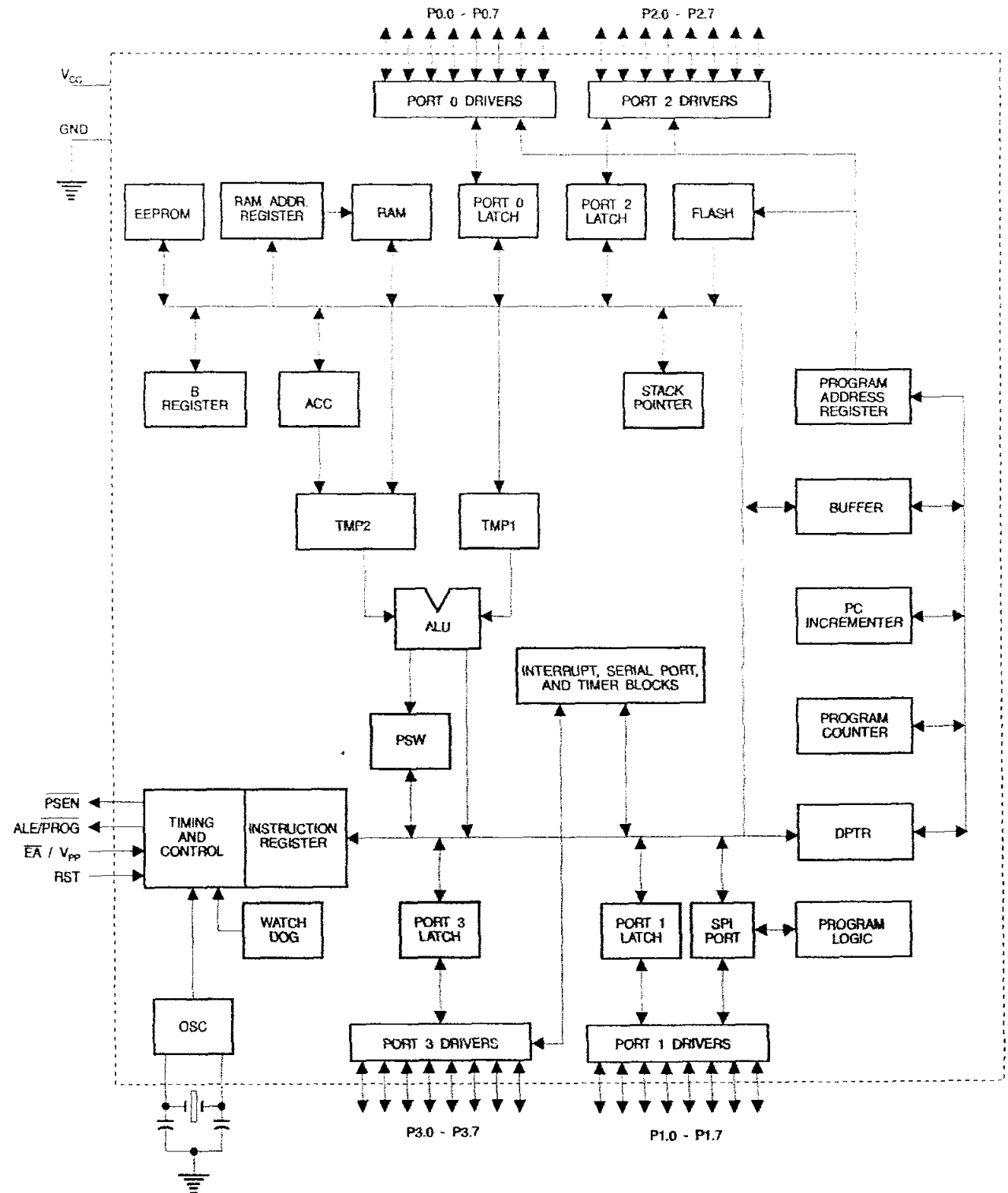
program and data memory. In this mode, P0 has internal pullups.

Port 0 also receives the code bytes during Flash programming and outputs the code bytes during program verification. External pullups are required during program verification.

Port 1

Port 1 is an 8-bit bi-directional I/O port with internal pullups. The Port 1 output buffers can sink/source four TTL inputs. When 1s are written to Port 1 pins, they are pulled high by the internal pullups and can be used as inputs. As inputs, Port 1 pins that are externally being pulled low will source current (I_{IL}) because of the internal pullups.

Block Diagram





me Port 1 pins provide additional functions. P1.0 and P1.1 can be configured to be the timer/counter 2 external count input (P1.0/T2) and the timer/counter 2 trigger input (P1.1/T2EX), respectively.

Port Description

Furthermore, P1.4, P1.5, P1.6, and P1.7 can be configured as the SPI slave port select, data input/output and shift clock input/output pins as shown in the following table.

Port Pin	Alternate Functions
P1.0	T2 (external count input to Timer/Counter 2), clock-out
P1.1	T2EX (Timer/Counter 2 capture/reload trigger and direction control)
P1.4	$\overline{SS}$ (Slave port select input)
P1.5	MOSI (Master data output, slave data input pin for SPI channel)
P1.6	MISO (Master data input, slave data output pin for SPI channel)
P1.7	SCK (Master clock output, slave clock input pin for SPI channel)

Port 1 also receives the low-order address bytes during Flash programming and verification.

Port 2

Port 2 is an 8-bit bi-directional I/O port with internal pullups. The Port 2 output buffers can sink/source four TTL inputs. When 1s are written to Port 2 pins, they are pulled high by the internal pullups and can be used as inputs. As inputs, Port 2 pins that are externally being pulled low will source current (I_{IL}) because of the internal pullups.

Port 2 emits the high-order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX @ PTR). In this application, Port 2 uses strong internal pullups when emitting 1s. During accesses to external data memory that use 8-bit addresses (MOVX @ RI), Port 2 shifts the contents of the P2 Special Function Register.

Port 2 also receives the high-order address bits and some control signals during Flash programming and verification.

Port 3

Port 3 is an 8 bit bi-directional I/O port with internal pullups. The Port 3 output buffers can sink/source four TTL inputs. When 1s are written to Port 3 pins, they are pulled high by the internal pullups and can be used as inputs. As inputs,

Port 3 pins that are externally being pulled low will source current (I_{IL}) because of the pullups.

Port 3 also serves the functions of various special features of the AT89S8252, as shown in the following table.

Port 3 also receives some control signals for Flash programming and verification.

Port Pin	Alternate Functions
P3.0	RXD (serial input port)
P3.1	TXD (serial output port)
P3.2	$\overline{INT0}$ (external interrupt 0)
P3.3	$\overline{INT1}$ (external interrupt 1)
P3.4	T0 (timer 0 external input)
P3.5	T1 (timer 1 external input)
P3.6	$\overline{WR}$ (external data memory write strobe)
P3.7	$\overline{RD}$ (external data memory read strobe)

RST

Reset input. A high on this pin for two machine cycles while the oscillator is running resets the device.

ALE/PROG

Address Latch Enable is an output pulse for latching the low byte of the address during accesses to external memory. This pin is also the program pulse input (PROG) during Flash programming.

In normal operation, ALE is emitted at a constant rate of 1/6 the oscillator frequency and may be used for external timing or clocking purposes. Note, however, that one ALE pulse is skipped during each access to external data memory.

If desired, ALE operation can be disabled by setting bit 0 of SFR location 8EH. With the bit set, ALE is active only during a MOVX or MOVC instruction. Otherwise, the pin is weakly pulled high. Setting the ALE-disable bit has no effect if the microcontroller is in external execution mode.

PSEN

Program Store Enable is the read strobe to external program memory.

When the AT89S8252 is executing code from external program memory, $\overline{PSEN}$ is activated twice each machine cycle, except that two $\overline{PSEN}$ activations are skipped during each access to external data memory.

$\overline{EA}/VPP$

External Access Enable. $\overline{EA}$ must be strapped to GND in order to enable the device to fetch code from external pro-

RAM memory locations starting at 0000H up to FFFFH. Note, however, that if lock bit 1 is programmed, EA will be externally latched on reset.

EA should be strapped to V_{CC} for internal program executions. This pin also receives the 12-volt programming enable voltage (V_{PP}) during Flash programming when 12-Volt programming is selected.

XTAL1

Input to the inverting oscillator amplifier and input to the internal clock operating circuit.

XTAL2

Output from the inverting oscillator amplifier.

Table 1. AT89S8252 SFR Map and Reset Values

0F8H								0FFH
0F0H	B 00000000							0F7H
0E8H								0EFH
0E0H	ACC 00000000							0E7H
0D8H								0DFH
0D0H	PSW 00000000				SPCR 000001XX			0D7H
0C8H	T2CON 00000000	T2MOD XXXXXX00	RCAP2L 00000000	RCAP2H 00000000	TL2 00000000	TH2 00000000		0CFH
0C0H								0C7H
0B8H	IP XX000000							0BFH
0B0H	P3 11111111							0B7H
0A8H	IE 0X000000		SPSR 00XXXXXX					0AFH
0A0H	P2 11111111							0A7H
98H	SCON 00000000	SBUF XXXXXXXX						9FH
90H	P1 11111111					WMCON 00000010		97H
88H	TCON 00000000	TMOD 00000000	TL0 00000000	TL1 00000000	TH0 00000000	TH1 00000000		8FH
80H	P0 11111111	SP 00000111	DP0L 00000000	DP0H 00000000	DP1L 00000000	DP1H 00000000	SPDR XXXXXXXX	PCON 0XXX0000



Special Function Registers

map of the on-chip memory area called the Special Function Register (SFR) space is shown in Table 1.

te that not all of the addresses are occupied, and unoccupied addresses may not be implemented on the chip. Read accesses to these addresses will in general return random data, and write accesses will have an indeterminate effect.

er software should not write 1s to these unlisted

locations, since they may be used in future products to invoke new features. In that case, the reset or inactive values of the new bits will always be 0.

Timer 2 Registers Control and status bits are contained in registers T2CON (shown in Table 2) and T2MOD (shown in Table 9) for Timer 2. The register pair (RCAP2H, RCAP2L) are the Capture/Reload registers for Timer 2 in 16 bit capture mode or 16-bit auto-reload mode.

Table 2. T2CON—Timer/Counter 2 Control Register

2CON Address = 0C8H

Reset Value = 0000 0000B

Bit Addressable

TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2	CP/RL2
7	6	5	4	3	2	1	0

Symbol	Function
TF2	Timer 2 overflow flag set by a Timer 2 overflow and must be cleared by software. TF2 will not be set when either RCLK = 1 or TCLK = 1.
EXF2	Timer 2 external flag set when either a capture or reload is caused by a negative transition on T2EX and EXEN2 = 1. When Timer 2 interrupt is enabled, EXF2 = 1 will cause the CPU to vector to the Timer 2 interrupt routine. EXF2 must be cleared by software. EXF2 does not cause an interrupt in up/down counter mode (DCEN = 1).
RCLK	Receive clock enable. When set, causes the serial port to use Timer 2 overflow pulses for its receive clock in serial port Modes 1 and 3. RCLK = 0 causes Timer 1 overflows to be used for the receive clock.
TCLK	Transmit clock enable. When set, causes the serial port to use Timer 2 overflow pulses for its transmit clock in serial port Modes 1 and 3. TCLK = 0 causes Timer 1 overflows to be used for the transmit clock.
EXEN2	Timer 2 external enable. When set, allows a capture or reload to occur as a result of a negative transition on T2EX if Timer 2 is not being used to clock the serial port. EXEN2 = 0 causes Timer 2 to ignore events at T2EX.
TR2	Start/Stop control for Timer 2. TR2 = 1 starts the timer.
C/T2	Timer or counter select for Timer 2. C/T2 = 0 for timer function. C/T2 = 1 for external event counter (falling edge triggered).
CP/RL2	Capture/Reload select. CP/RL2 = 1 causes captures to occur on negative transitions at T2EX if EXEN2 = 1. CP/RL2 = 0 causes automatic reloads to occur when Timer 2 overflows or negative transitions occur at T2EX when EXEN2 = 1. When either RCLK or TCLK = 1, this bit is ignored and the timer is forced to auto-reload on Timer 2 overflow.

Watchdog and Memory Control Register The WMCON register contains control bits for the Watchdog Timer (shown in Table 3). The EEMEN and EEMWE bits are used

to select the 2K bytes on-chip EEPROM, and to enable byte-write. The DPS bit selects one of two DPTR registers available.

Table 3. WMCON—Watchdog and Memory Control Register

WMCON Address = 96H						Reset Value = 0000 0010B	
PS2	PS1	PS0	EEMWE	EEMEN	DPS	WDTRST	WDTEN
7	6	5	4	3	2	1	0
Symbol	Function						
PS2 PS1 PS0	Prescaler Bits for the Watchdog Timer. When all three bits are set to "0", the watchdog timer has a nominal period of 16 ms. When all three bits are set to "1", the nominal period is 2048 ms.						
EEMWE	EEPROM Data Memory Write Enable Bit. Set this bit to "1" before initiating byte write to on-chip EEPROM with the MOVX instruction. User software should set this bit to "0" after EEPROM write is completed.						
EEMEN	Internal EEPROM Access Enable. When EEMEN = 1, the MOVX instruction with DPTR will access on-chip EEPROM instead of external data memory. When EEMEN = 0, MOVX with DPTR accesses external data memory.						
DPS	Data Pointer Register Select. DPS = 0 selects the first bank of Data Pointer Register, DP0, and DPS = 1 selects the second bank, DP1						
WDTRST RDY/BSY	Watchdog Timer Reset and EEPROM Ready/Busy Flag. Each time this bit is set to "1" by user software, a pulse is generated to reset the watchdog timer. The WDTRST bit is then automatically reset to "0" in the next instruction cycle. The WDTRST bit is Write-Only. This bit also serves as the RDY/BSY flag in a Read-Only mode during EEPROM write. RDY/BSY = 1 means that the EEPROM is ready to be programmed. While programming operations are being executed, the RDY/BSY bit equals "0" and is automatically reset to "1" when programming is completed.						
WDTEN	Watchdog Timer Enable Bit. WDTEN = 1 enables the watchdog timer and WDTEN = 0 disables the watchdog timer.						

SPI Registers Control and status bits for the Serial Peripheral Interface are contained in registers SPSCR (shown in Table 4) and SPSR (shown in Table 5). The SPI data bits are contained in the SPDR register. Writing the SPI data register during serial data transfer sets the Write Collision Flag, WCOL, in the SPSR register. The SPDR is double buffered for writing and the values in SPDR are not changed by a read.

Interrupt Registers The global interrupt enable bit and the individual interrupt enable bits are in the IE register. In addition, the individual interrupt enable bit for the SPI is in the SPSCR register. Two priorities can be set for each of the eight interrupt sources in the IP register.

Dual Data Pointer Registers To facilitate accessing both internal EEPROM and external data memory, two banks of 16 bit Data Pointer Registers are provided: DP0 at SFR address locations 82H-83H and DP1 at 84H-85H. Bit DPS = 0 in SFR WMCON selects DP0 and DPS = 1 selects DP1. The user should always initialize the DPS bit to the appropriate value before accessing the respective Data Pointer Register.

Power Off Flag The Power Off Flag (POF) is located at bit 4 (PCON.4) in the PCON SFR. POF is set to "1" during power up. It can be set and reset under software control and is not affected by RESET.



Table 4. SPCR—SPI Control Register

SPCR Address = D5H

Reset Value = 00G0 01XXB

	SPIE	SPE	DORD	MSTR	CPOL	CPHA	SPR1	SPR0
Bit	7	6	5	4	3	2	1	0

Symbol	Function
SPIE	SPI Interrupt Enable. This bit, in conjunction with the ES bit in the IE register, enables SPI interrupts: SPIE = 1 and ES = 1 enable SPI interrupts. SPIE = 0 disables SPI interrupts.
SPE	SPI Enable. SPI = 1 enables the SPI channel and connects $\overline{SS}$, MOSI, MISO and SCK to pins P1.4, P1.5, P1.6, and P1.7. SPI = 0 disables the SPI channel.
DORD	Data Order. DORD = 1 selects LSB first data transmission. DORD = 0 selects MSB first data transmission.
MSTR	Master/Slave Select. MSTR = 1 selects Master SPI mode. MSTR = 0 selects Slave SPI mode.
CPOL	Clock Polarity. When CPOL = 1, SCK is high when idle. When CPOL = 0, SCK of the master device is low when not transmitting. Please refer to figure on SPI Clock Phase and Polarity Control.
CPHA	Clock Phase. The CPHA bit together with the CPOL bit controls the clock and data relationship between master and slave. Please refer to figure on SPI Clock Phase and Polarity Control.
SPR0 SPR1	SPI Clock Rate Select. These two bits control the SCK rate of the device configured as master. SPR1 and SPR0 have no effect on the slave. The relationship between SCK and the oscillator frequency, F_{osc} , is as follows: SPR1SPR0 SCK = F_{osc} divided by 0 0 4 0 1 16 1 0 64 1 1 128

Table 5. SPSR – SPI Status Register

SPSR Address = AAH

Reset Value = 00XX XXXXB

SPIF	WCOL	—	—	—	—	—	—
7	6	5	4	3	2	1	0

Symbol	Function
SPIF	SPI Interrupt Flag. When a serial transfer is complete, the SPIF bit is set and an interrupt is generated if SPIE = 1 and ES = 1. The SPIF bit is cleared by reading the SPI status register with SPIF and WCOL bits set, and then accessing the SPI data register.
WCOL	Write Collision Flag. The WCOL bit is set if the SPI data register is written during a data transfer. During data transfer, the result of reading the SPDR register may be incorrect, and writing to it has no effect. The WCOL bit (and the SPIF bit) are cleared by reading the SPI status register with SPIF and WCOL set, and then accessing the SPI data register.

Table 6. SPDR – SPI Data Register

SPDR Address = 86H

Reset Value = unchanged

	SPD7	SPD6	SPD5	SPD4	SPD3	SPD2	SPD1	SPD0
Bit	7	6	5	4	3	2	1	0

Data Memory – EEPROM and RAM

The AT89S8252 implements 2K bytes of on-chip EEPROM for data storage and 256 bytes of RAM. The upper 128 bytes of RAM occupy a parallel space to the Special Function Registers. That means the upper 128 bytes have the same addresses as the SFR space but are physically separate from SFR space.

When an instruction accesses an internal location above address 7FH, the address mode used in the instruction specifies whether the CPU accesses the upper 128 bytes of RAM or the SFR space. Instructions that use direct addressing access SFR space.

For example, the following direct addressing instruction accesses the SFR at location 0A0H (which is P2).

```
MOV 0A0H, #data
```

Instructions that use indirect addressing access the upper 128 bytes of RAM. For example, the following indirect addressing instruction, where R0 contains 0A0H, accesses the data byte at address 0A0H, rather than P2 (whose address is 0A0H).

```
MOV @R0, #data
```

Note that stack operations are examples of indirect addressing, so the upper 128 bytes of data RAM are available as stack space.

The on-chip EEPROM data memory is selected by setting the EEMEN bit in the WMCON register at SFR address location 96H. The EEPROM address range is from 000H to 7FH. The MOVX instructions are used to access the EEPROM. To access off-chip data memory with the MOVX instructions, the EEMEN bit needs to be set to "0".

The EEMWE bit in the WMCON register needs to be set to "1" before any byte location in the EEPROM can be written. After software should reset EEMWE bit to "0" if no further EEPROM write is required. EEPROM write cycles in the normal programming mode are self-timed and typically take 5 ms. The progress of EEPROM write can be monitored by reading the RDY/BSY bit (read-only) in SFR WMCON. RDY/BSY = 0 means programming is still in progress and RDY/BSY = 1 means EEPROM write cycle is completed and another write cycle can be initiated.

In addition, during EEPROM programming, an attempted read from the EEPROM will fetch the byte being written with the MSB complemented. Once the write cycle is completed, true data are valid at all bit locations.

Programmable Watchdog Timer

The programmable Watchdog Timer (WDT) operates from an independent oscillator. The prescaler bits, PS0, PS1 and PS2 in SFR WMCON are used to set the period of the Watchdog Timer from 16 ms to 2048 ms. The available timer periods are shown in the following table and the

actual timer periods (at $V_{CC} = 5V$) are within $\pm 30\%$ of the nominal.

The WDT is disabled by Power-on Reset and during Power-down. It is enabled by setting the WDTEN bit in SFR WMCON (address = 96H). The WDT is reset by setting the WDTRST bit in WMCON. When the WDT times out without being reset or disabled, an internal RST pulse is generated to reset the CPU.

Table 7. Watchdog Timer Period Selection

WDT Prescaler Bits			Period (nominal)
PS2	PS1	PS0	
0	0	0	16 ms
0	0	1	32 ms
0	1	0	64 ms
0	1	1	128 ms
1	0	0	256 ms
1	0	1	512 ms
1	1	0	1024 ms
1	1	1	2048 ms

Timer 0 and 1

Timer 0 and Timer 1 in the AT89S8252 operate the same way as Timer 0 and Timer 1 in the AT89C51, AT89C52 and AT89C55. For further information, see the October 1995 Microcontroller Data Book, page 2-45, section titled, "Timer/Counters."

Timer 2

Timer 2 is a 16 bit Timer/Counter that can operate as either a timer or an event counter. The type of operation is selected by bit C/T2 in the SFR T2CON (shown in Table 2). Timer 2 has three operating modes: capture, auto-reload (up or down counting), and baud rate generator. The modes are selected by bits in T2CON, as shown in Table 8.

Timer 2 consists of two 8-bit registers, TH2 and TL2. In the Timer function, the TL2 register is incremented every machine cycle. Since a machine cycle consists of 12 oscillator periods, the count rate is 1/12 of the oscillator frequency.

In the Counter function, the register is incremented in response to a 1-to-0 transition at its corresponding external input pin, T2. In this function, the external input is sampled during S5P2 of every machine cycle. When the samples show a high in one cycle and a low in the next cycle, the count is incremented. The new count value appears in the register during S3P1 of the cycle following the one in which

the transition was detected. Since two machine cycles (24 oscillator periods) are required to recognize a 1-to-0 transition, the maximum count rate is 1/24 of the oscillator frequency. To ensure that a given level is sampled at least once before it changes, the level should be held for at least one full machine cycle.

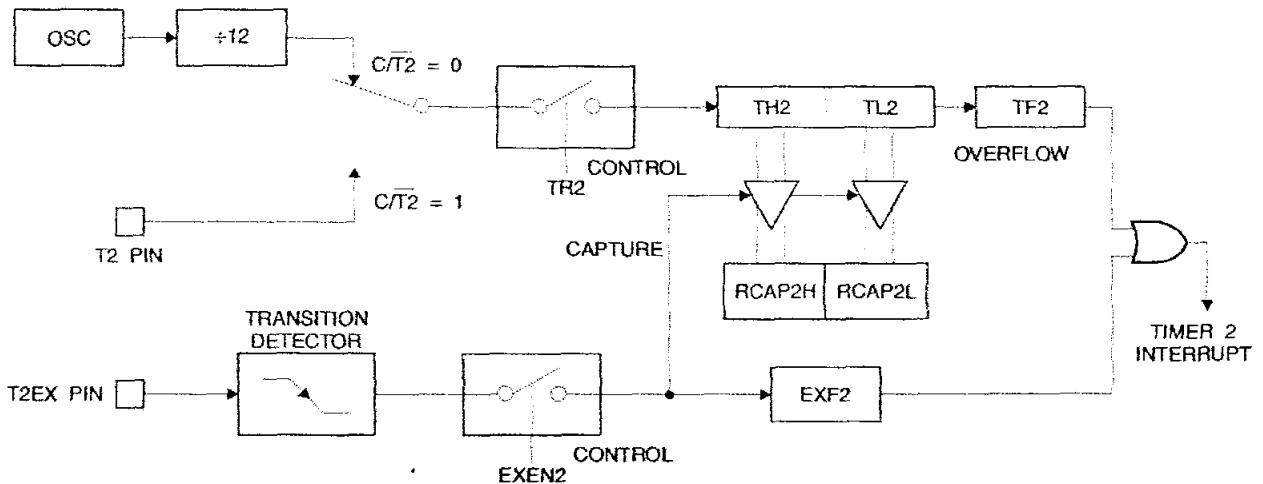
Table 8. Timer 2 Operating Modes

RCLK + TCLK	CP/RL2	TR2	MODE
0	0	1	16-bit Auto-reload
0	1	1	16-bit Capture
1	X	1	Baud Rate Generator
X	X	0	(Off)

Capture Mode

In the capture mode, two options are selected by bit EXEN2 in T2CON. If EXEN2 = 0, Timer 2 is a 16 bit timer or counter which upon overflow sets bit TF2 in T2CON. This bit can then be used to generate an interrupt. If EXEN2 = 1, Timer 2 performs the same operation, but a 1-to-0 transition at external input T2EX also causes the current value in TH2 and TL2 to be captured into RCAP2H and RCAP2L, respectively. In addition, the transition at T2EX causes bit EXF2 in T2CON to be set. The EXF2 bit, like TF2, can generate an interrupt. The capture mode is illustrated in Figure 1.

Figure 1. Timer 2 in Capture Mode



Auto-reload (Up or Down Counter)

Timer 2 can be programmed to count up or down when configured in its 16 bit auto-reload mode. This feature is controlled by the DCEN (Down Counter Enable) bit located in SFR T2MOD (see Table 9). Upon reset, the DCEN bit is set to 0 so that timer 2 will default to count up. When DCEN is set, Timer 2 can count up or down, depending on the value of the T2EX pin.

Figure 2 shows Timer 2 automatically counting up when DCEN = 0. In this mode, two options are selected by bit EXEN2 in T2CON. If EXEN2 = 0, Timer 2 counts up to 0FFFFH and then sets the TF2 bit upon overflow. The overflow also causes the timer registers to be reloaded with the 16 bit value in RCAP2H and RCAP2L. The values in RCAP2H and RCAP2L are preset by software. If EXEN2 = 1, a 16 bit reload can be triggered either by an overflow or

by a 1-to-0 transition at external input T2EX. This transition also sets the EXF2 bit. Both the TF2 and EXF2 bits can generate an interrupt if enabled.

Setting the DCEN bit enables Timer 2 to count up or down, as shown in Figure 3. In this mode, the T2EX pin controls the direction of the count. A logic 1 at T2EX makes Timer 2 count up. The timer will overflow at 0FFFFH and set the TF2 bit. This overflow also causes the 16 bit value in RCAP2H and RCAP2L to be reloaded into the timer registers, TH2 and TL2, respectively.

A logic 0 at T2EX makes Timer 2 count down. The timer underflows when TH2 and TL2 equal the values stored in RCAP2H and RCAP2L. The underflow sets the TF2 bit and causes 0FFFFH to be reloaded into the timer registers.

The EXF2 bit toggles whenever Timer 2 overflows or underflows and can be used as a 17th bit of resolution. In this operating mode, EXF2 does not flag an interrupt.

Figure 2. Timer 2 in Auto Reload Mode (DCEN = 0)

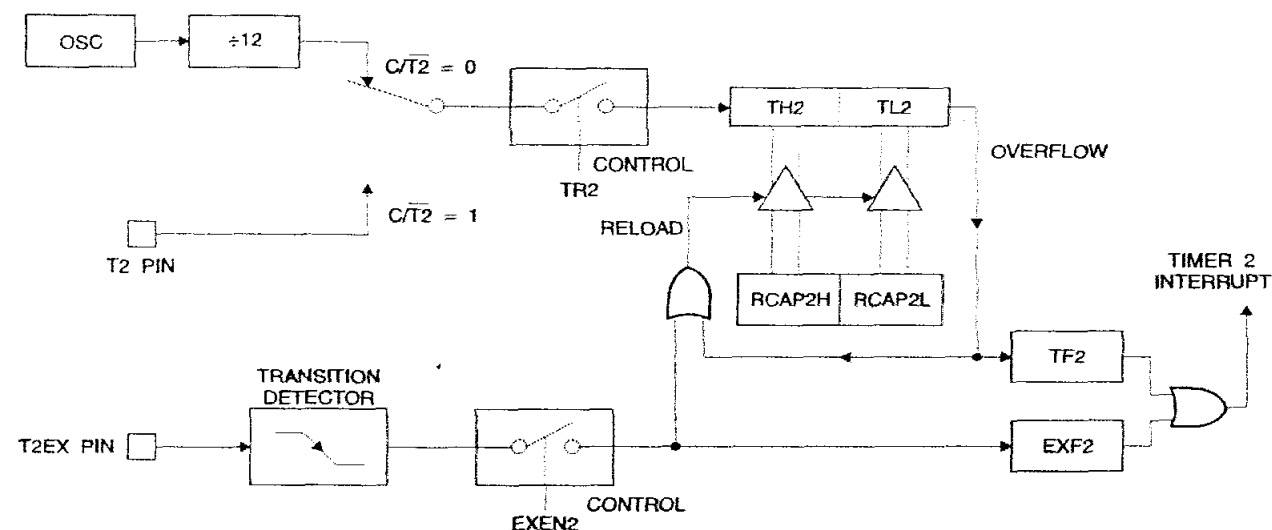


Table 9. T2MOD – Timer 2 Mode Control Register

T2MOD Address = 0C9H								Reset Value = XXXX XX00B	
Not Bit Addressable									
Bit	7	6	5	4	3	2	1	0	
Symbol	–	–	–	–	–	–	T2OE	DCEN	
Function	Not implemented, reserved for future use.								
T2OE	Timer 2 Output Enable bit.								
DCEN	When set, this bit allows Timer 2 to be configured as an up/down counter.								

(DOWN COUNTING RELOAD VALUE)

0FFH 0FFH

OSC → ÷12 → C/T2 = 0

C/T2 = 1

T2 PIN

CONTROL

TR2

TH2 TL2

RCAP2H RCAP2L

(UP COUNTING RELOAD VALUE)

OVERFLOW

TOGGLE

EXF2

TF2

TIMER 2 INTERRUPT

COUNT DIRECTION
1=UP
0=DOWN

T2EX PIN

The diagram illustrates the internal architecture of the 8051 timer module. It starts with an oscillator (OSC) whose frequency is divided by 2. This signal is used to generate the $C/T2 = 0$ signal. The $C/T2 = 1$ signal is generated from the T2 PIN. The timer module consists of two main parts: Timer 1 and Timer 2. Timer 1 includes a TH1 register, a TL1 register, and a RCAP1H/RCAP1L register. It is controlled by the TR1 bit in the TCON register. Timer 2 includes a TH2 register, a TL2 register, and a RCAP2H/RCAP2L register. It is controlled by the TR2 bit in the TCON register. The timer module also includes a transition detector for the T2EX PIN, which generates the EXF2 interrupt flag. The timer module is also connected to the SMD1 pin, which is used to select between different timer modes. The timer module is also connected to the RCLK and TCLK pins, which are used to clock the timer registers. The timer module is also connected to the Rx and Tx pins, which are used for serial communication.

Baud Rate Generator

Timer 2 is selected as the baud rate generator by setting CLK and/or RCLK in T2CON (Table 2). Note that the baud rates for transmit and receive can be different if Timer 2 is used for the receiver or transmitter and Timer 1 is used for the other function. Setting RCLK and/or TCLK puts Timer 2 into its baud rate generator mode, as shown in Figure 4.

The baud rate generator mode is similar to the auto-reload mode, in that a rollover in TH2 causes the Timer 2 registers to be reloaded with the 16 bit value in registers RCAP2H and RCAP2L, which are preset by software.

The baud rates in Modes 1 and 3 are determined by Timer 2's overflow rate according to the following equation.

$$\text{Modes 1 and 3 Baud Rates} = \frac{\text{Timer 2 Overflow Rate}}{16}$$

The Timer can be configured for either timer or counter operation. In most applications, it is configured for timer operation ($CP/\overline{T2} = 0$). The timer operation is different for Timer 2 when it is used as a baud rate generator. Normally, as a timer, it increments every machine cycle (at 1/12 the oscillator frequency). As a baud rate generator, however, it increments every state time (at 1/2 the oscillator frequency). The baud rate formula is given below.

$$\frac{\text{Modes 1 and 3 Baud Rate}}{1} = \frac{\text{Oscillator Frequency}}{32 \times [65536 - (RCAP2H, RCAP2L)]}$$

where (RCAP2H, RCAP2L) is the content of RCAP2H and RCAP2L taken as a 16 bit unsigned integer.

Timer 2 as a baud rate generator is shown in Figure 4. This figure is valid only if RCLK or TCLK = 1 in T2CON. Note that a rollover in TH2 does not set TF2 and will not generate an interrupt. Note too, that if EXEN2 is set, a 1-to-0 transition in T2EX will set EXF2 but will not cause a reload from (RCAP2H, RCAP2L) to (TH2, TL2). Thus when Timer

2 is in use as a baud rate generator, T2EX can be used as an extra external interrupt.

Note that when Timer 2 is running ($TR2 = 1$) as a timer in the baud rate generator mode, TH2 or TL2 should not be read from or written to. Under these conditions, the Timer is incremented every state time, and the results of a read or write may not be accurate. The RCAP2 registers may be read but should not be written to, because a write might overlap a reload and cause write and/or reload errors. The timer should be turned off (clear TR2) before accessing the Timer 2 or RCAP2 registers.

Programmable Clock Out

A 50% duty cycle clock can be programmed to come out on P1.0, as shown in Figure 5. This pin, besides being a regular I/O pin, has two alternate functions. It can be programmed to input the external clock for Timer/Counter 2 or to output a 50% duty cycle clock ranging from 61 Hz to 4 MHz at a 16 MHz operating frequency.

To configure the Timer/Counter 2 as a clock generator, bit $C/\overline{T2}$ (T2CON.1) must be cleared and bit T2OE (T2MOD.1) must be set. Bit TR2 (T2CON.2) starts and stops the timer. The clock-out frequency depends on the oscillator frequency and the reload value of Timer 2 capture registers (RCAP2H, RCAP2L), as shown in the following equation.

$$\text{Clock Out Frequency} = \frac{\text{Oscillator Frequency}}{4 \times [65536 - (RCAP2H, RCAP2L)]}$$

In the clock-out mode, Timer 2 rollovers will not generate an interrupt. This behavior is similar to when Timer 2 is used as a baud-rate generator. It is possible to use Timer 2 as a baud-rate generator and a clock generator simultaneously. Note, however, that the baud-rate and clock-out frequencies cannot be determined independently from one another since they both use RCAP2H and RCAP2L.

Figure 5. Timer 2 in Clock-out Mode

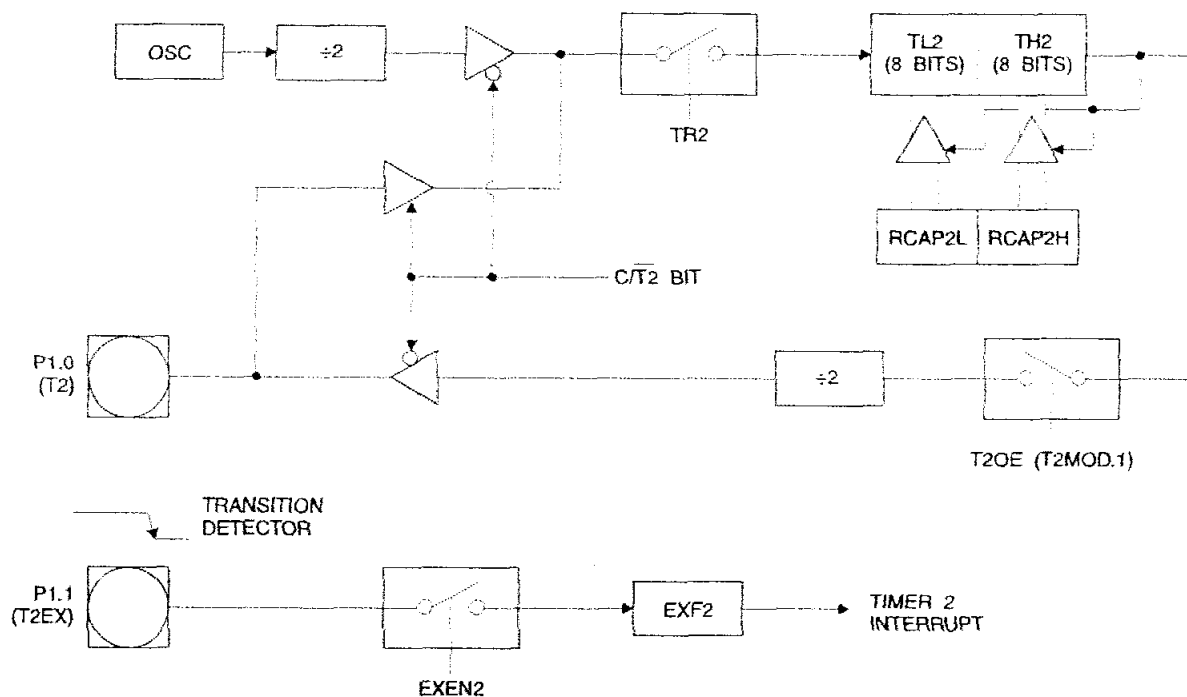
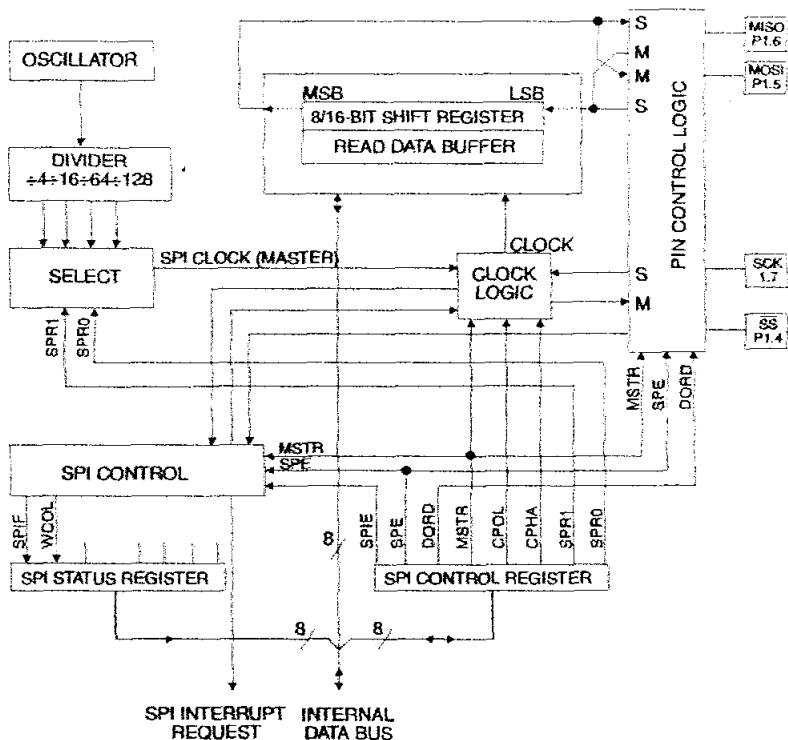


Figure 6. SPI Block Diagram



UART

The UART in the AT89S8252 operates the same way as the UART in the AT89C51, AT89C52 and AT89C55. For further information, see the October 1995 Microcontroller Data Book, page 2-49, section titled, "Serial Interface."

Serial Peripheral Interface

The serial peripheral interface (SPI) allows high-speed synchronous data transfer between the AT89S8252 and peripheral devices or between several AT89S8252 devices. The AT89S8252 SPI features include the following:

- Full-Duplex, 3-Wire Synchronous Data Transfer
- Master or Slave Operation
- 1.5 MHz Bit Frequency (max.)
- LSB First or MSB First Data Transfer
- Four Programmable Bit Rates
- End of Transmission Interrupt Flag

- Write Collision Flag Protection
- Wake-up from Idle Mode (Slave Mode Only)

The interconnection between master and slave CPUs with SPI is shown in the following figure. The SCK pin is the clock output in the master mode but is the clock input in the slave mode. Writing to the SPI data register of the master CPU starts the SPI clock generator, and the data written shifts out of the MOSI pin and into the MISO pin of the slave CPU. After shifting one byte, the SPI clock generator stops, setting the end of transmission flag (SPIF). If both the SPI interrupt enable bit (SPIE) and the serial port interrupt enable bit (ES) are set, an interrupt is requested.

The Slave Select input, $\overline{SS}/P1.4$, is set low to select an individual SPI device as a slave. When $\overline{SS}/P1.4$ is set high, the SPI port is deactivated and the MOSI/P1.5 pin can be used as an input.

There are four combinations of SCK phase and polarity with respect to serial data, which are determined by control bits CPHA and CPOL. The SPI data transfer formats are shown in Figure 8 and Figure 9.

Figure 7. SPI Master-slave Interconnection

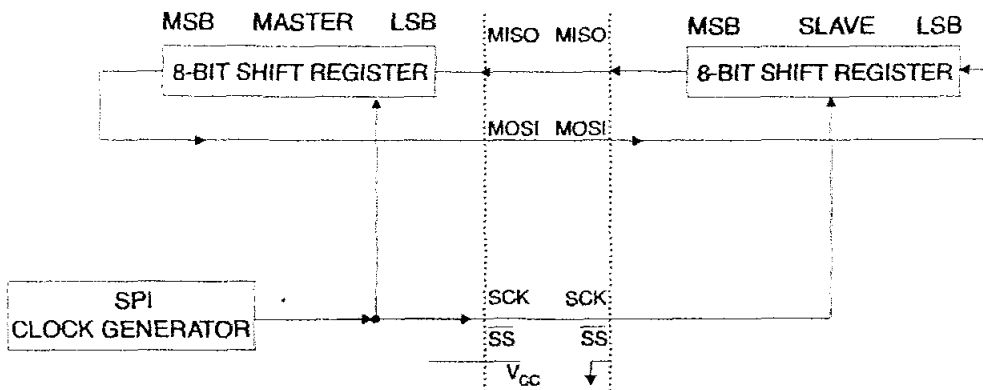
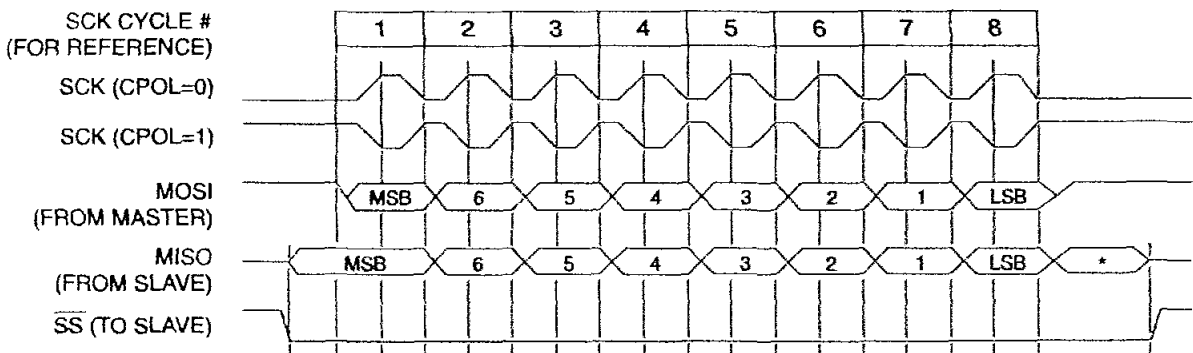
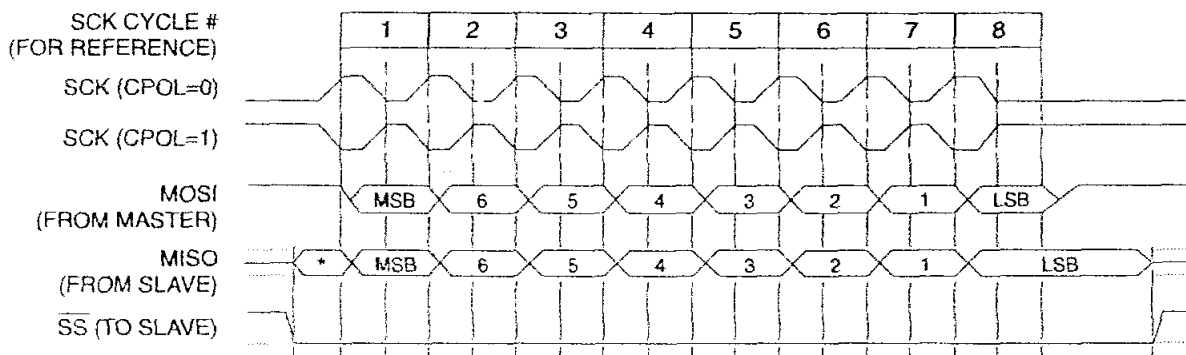


Figure 8. SPI transfer Format with CPHA = 0



not defined but normally MSB of character just received

Figure 9. SPI Transfer Format with CPHA = 1



not defined but normally LSB of previously transmitted character

Interrupts

The AT89S8252 has a total of six interrupt vectors: two external interrupts ($\overline{INT0}$ and $\overline{INT1}$), three timer interrupts (timers 0, 1, and 2), and the serial port interrupt. These interrupts are all shown in Figure 10.

Each of these interrupt sources can be individually enabled or disabled by setting or clearing a bit in Special Function register IE. IE also contains a global disable bit, EA, which disables all interrupts at once.

Note that Table 10 shows that bit position IE.6 is unimplemented. In the AT89C51, bit position IE.5 is also unimplemented. User software should not write 1s to these bit positions, since they may be used in future AT89 products.

Timer 2 interrupt is generated by the logical OR of bits TF2 and EXF2 in register T2CON. Neither of these flags is cleared by hardware when the service routine is vectored to it. In fact, the service routine may have to determine whether it was TF2 or EXF2 that generated the interrupt, and that bit will have to be cleared in software.

The Timer 0 and Timer 1 flags, TF0 and TF1, are set at S2P2 of the cycle in which the timers overflow. The values are then polled by the circuitry in the next cycle. However, the Timer 2 flag, TF2, is set at S2P2 and is polled in the same cycle in which the timer overflows.

Table 10. Interrupt Enable (IE) Register

(MSB)(LSB)

EA

—

ET2

ES

ET1

EX1

ET0

EX0

Enable Bit = 1 enables the interrupt.

Enable Bit = 0 disables the interrupt.

Symbol

Position

Function

EA

IE.7

Disables all interrupts. If EA = 0, no interrupt is acknowledged. If EA = 1, each interrupt source is individually enabled or disabled by setting or clearing its enable bit.

—

IE.6

Reserved.

ET2

IE.5

Timer 2 interrupt enable bit.

ES

IE.4

SPI and UART interrupt enable bit.

ET1

IE.3

Timer 1 interrupt enable bit.

EX1

IE.2

External interrupt 1 enable bit.

ET0

IE.1

Timer 0 interrupt enable bit.

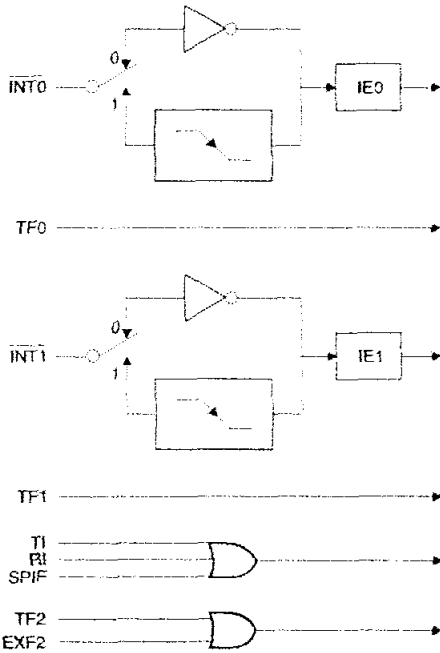
EX0

IE.0

External interrupt 0 enable bit.

User software should never write 1s to unimplemented bits, because they may be used in future AT89 products.

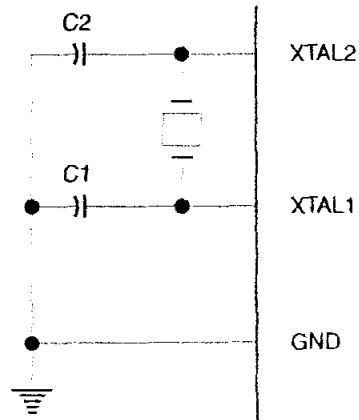
Figure 10. Interrupt Sources



Oscillator Characteristics

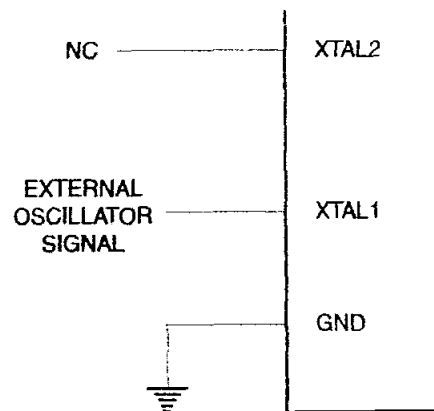
XTAL1 and XTAL2 are the input and output, respectively, of an on-chip inverting amplifier that can be configured for use as an on-chip oscillator, as shown in Figure 11. Either a quartz crystal or ceramic resonator may be used. To drive the device from an external clock source, XTAL2 should be left unconnected while XTAL1 is driven, as shown in Figure 12. There are no requirements on the duty cycle of the external clock signal, since the input to the internal clocking circuitry is through a divide-by-two flip-flop, but minimum and maximum voltage high and low time specifications must be observed.

Figure 11. Oscillator Connections



Note: Note: C1, C2 = 30 pF $\pm$ 10 pF for Crystals
= 40 pF $\pm$ 10 pF for Ceramic Resonators

Figure 12. External Clock Drive Configuration





Idle Mode

In idle mode, the CPU puts itself to sleep while all the on-chip peripherals remain active. The mode is invoked by software. The content of the on-chip RAM and all the special function registers remain unchanged during this mode. The idle mode can be terminated by any enabled interrupt or by a hardware reset.

Note that when idle mode is terminated by a hardware reset, the device normally resumes program execution

from where it left off, up to two machine cycles before the internal reset algorithm takes control. On-chip hardware inhibits access to internal RAM in this event, but access to the port pins is not inhibited. To eliminate the possibility of an unexpected write to a port pin when idle mode is terminated by a reset, the instruction following the one that invokes idle mode should not write to a port pin or to external memory.

Status of External Pins During Idle and Power-down Modes

Mode	Program Memory	ALE	PSEN	PORT0	PORT1	PORT2	PORT3
Idle	Internal	1	1	Data	Data	Data	Data
Idle	External	1	1	Float	Data	Address	Data
Power-down	Internal	0	0	Data	Data	Data	Data
Power-down	External	0	0	Float	Data	Data	Data

Power-down Mode

In the power-down mode, the oscillator is stopped and the instruction that invokes power-down is the last instruction executed. The on-chip RAM and Special Function Registers retain their values until the power-down mode is terminated. Exit from power-down can be initiated either by hardware reset or by an enabled external interrupt. Reset defines the SFRs but does not change the on-chip RAM. The reset should not be activated before V_{CC} is restored to normal operating level and must be held active long enough to allow the oscillator to restart and stabilize.

To exit power-down via an interrupt, the external interrupt must be enabled as level sensitive before entering power-down. The interrupt service routine starts at 16 ms (nominal) after the enabled interrupt pin is activated.

Program Memory Lock Bits

The AT89S8252 has three lock bits that can be left unprogrammed (U) or can be programmed (P) to obtain the additional features listed in the following table.

When lock bit 1 is programmed, the logic level at the $\overline{EA}$ pin is sampled and latched during reset. If the device is powered up without a reset, the latch initializes to a random value and holds that value until reset is activated. The latched value of $\overline{EA}$ must agree with the current logic level at that pin in order for the device to function properly.

Once programmed, the lock bits can only be unprogrammed with the Chip Erase operations in either the parallel or serial modes.

Lock Bit Protection Modes⁽¹⁾⁽²⁾

Program Lock Bits				Protection Type
	LB1	LB2	LB3	
1	U	U	U	No internal memory lock feature.
2	P	U	U	MOVX instructions executed from external program memory are disabled from fetching code bytes from internal memory. $\overline{EA}$ is sampled and latched on reset and further programming of the Flash memory (parallel or serial mode) is disabled.
3	P	P	U	Same as Mode 2, but parallel or serial verify are also disabled.
4	P	P	P	Same as Mode 3, but external execution is also disabled.

Notes: 1. U = Unprogrammed
2. P = Programmed

Programming the Flash and EEPROM

Atmel's AT89S8252 Flash Microcontroller offers 8K bytes of on-system reprogrammable Flash Code memory and 2K bytes of EEPROM Data memory.

The AT89S8252 is normally shipped with the on-chip Flash Code and EEPROM Data memory arrays in the erased state (i.e. contents = FFH) and ready to be programmed. This device supports a High-voltage (12V) Parallel programming mode and a Low-voltage (5V) Serial programming mode. The serial programming mode provides a convenient way to download the AT89S8252 inside the user's system. The parallel programming mode is compatible with conventional third party Flash or EPROM programmers.

The Code and Data memory arrays are mapped via separate address spaces in the serial programming mode. In the parallel programming mode, the two arrays occupy one contiguous address space: 0000H to 1FFFH for the Code array and 2000H to 27FFH for the Data array.

The Code and Data memory arrays on the AT89S8252 are programmed byte-by-byte in either programming mode. An auto-erase cycle is provided with the self-timed programming operation in the serial programming mode. There is no need to perform the Chip Erase operation to reprogram any memory location in the serial programming mode unless any of the lock bits have been programmed.

In the parallel programming mode, there is no auto-erase cycle. To reprogram any non-blank byte, the user needs to perform the Chip Erase operation first to erase both arrays.

Parallel Programming Algorithm: To program and verify the AT89S8252 in the parallel programming mode, the following sequence is recommended:

- Power-up sequence:
- Apply power between V_{CC} and GND pins.
- Set RST pin to "H".
- Apply a 3 MHz to 24 MHz clock to XTAL1 pin and wait for at least 10 milliseconds.
- Set PSEN pin to "L".
- ALE pin to "H".
- $\overline{EA}$ pin to "H" and all other pins to "H".
- Apply the appropriate combination of "H" or "L" logic levels to pins P2.6, P2.7, P3.6, P3.7 to select one of the programming operations shown in the Flash Programming Modes table.
- Apply the desired byte address to pins P1.0 to P1.7 and P2.0 to P2.5.
- Apply data to pins P0.0 to P0.7 for Write Code operation.

5. Raise $\overline{EA}/V_{PP}$ to 12V to enable Flash programming, erase or verification.
6. Pulse ALE/ $\overline{PROG}$ once to program a byte in the Code memory array, the Data memory array or the lock bits. The byte-write cycle is self-timed and typically takes 1.5 ms.
7. To verify the byte just programmed, bring pin P2.7 to "L" and read the programmed data at pins P0.0 to P0.7.
8. Repeat steps 3 through 7 changing the address and data for the entire 2K or 8K bytes array or until the end of the object file is reached.
9. Power-off sequence:
 - Set XTAL1 to "L".
 - Set RST and $\overline{EA}$ pins to "L".
 - Turn V_{CC} power off.

In the parallel programming mode, there is no auto-erase cycle and to reprogram any non-blank byte, the user needs to use the Chip Erase operation first to erase both arrays.

Data Polling: The AT89S8252 features $\overline{DATA}$ Polling to indicate the end of a write cycle. During a write cycle in the parallel or serial programming mode, an attempted read of the last byte written will result in the complement of the written datum on P0.7 (parallel mode), and on the MSB of the serial output byte on MISO (serial mode). Once the write cycle has been completed, true data are valid on all outputs, and the next cycle may begin. $\overline{DATA}$ Polling may begin any time after a write cycle has been initiated.

Ready/Busy: The progress of byte programming in the parallel programming mode can also be monitored by the RDY/ $\overline{BSY}$ output signal. Pin P3.4 is pulled Low after ALE goes High during programming to indicate $\overline{BSY}$. P3.4 is pulled High again when programming is done to indicate READY.

Program Verify: If lock bits LB1 and LB2 have not been programmed, the programmed Code or Data byte can be read back via the address and data lines for verification. The state of the lock bits can also be verified directly in the parallel programming mode. In the serial programming mode, the state of the lock bits can only be verified indirectly by observing that the lock bit features are enabled.

Chip Erase: Both Flash and EEPROM arrays are erased electrically at the same time. In the parallel programming mode, chip erase is initiated by using the proper combination of control signals and by holding ALE/ $\overline{PROG}$ low for 10 ms. The Code and Data arrays are written with all "1"s in the Chip Erase operation.



In the serial programming mode, a chip erase operation is initiated by issuing the Chip Erase instruction. In this mode, chip erase is self-timed and takes about 16 ms.

During chip erase, a serial read from any address location will return 00H at the data outputs.

Serial Programming Fuse: A programmable fuse is available to disable Serial Programming if the user needs maximum system security. The Serial Programming Fuse can only be programmed or erased in the Parallel Programming Mode.

The AT89S8252 is shipped with the Serial Programming mode enabled.

Reading the Signature Bytes: The signature bytes are read by the same procedure as a normal verification of operations 030H and 031H, except that P3.6 and P3.7 must be pulled to a logic low. The values returned are as follows:

(030H) = 1EH indicates manufactured by Atmel
(031H) = 72H indicates 89S8252

Programming Interface

Every code byte in the Flash and EEPROM arrays can be written, and the entire array can be erased, by using the appropriate combination of control signals. The write operation cycle is self-timed and once initiated, will automatically time itself to completion.

Major programming vendors offer worldwide support for the Atmel microcontroller series. Please contact your local programming vendor for the appropriate software revision.

Serial Downloading

Both the Code and Data memory arrays can be programmed using the serial SPI bus while RST is pulled to low. The serial interface consists of pins SCK, MOSI (input) and MISO (output). After RST is set high, the Programming Enable instruction needs to be executed first before program/erase operations can be executed.

A auto-erase cycle is built into the self-timed programming operation (in the serial mode ONLY) and there is no need to first execute the Chip Erase instruction unless any of the lock bits have been programmed. The Chip Erase operation turns the content of every memory location in both the Code and Data arrays into FFH.

The Code and Data memory arrays have separate address spaces:

0000H to 1FFFH for Code memory and 000H to 7FFH for Data memory.

Either an external system clock is supplied at pin XTAL1 or a crystal needs to be connected across pins XTAL1 and XTAL2. The maximum serial clock (SCK) frequency should be less than 1/40 of the crystal frequency. With a 24 MHz oscillator clock, the maximum SCK frequency is 600 kHz.

Serial Programming Algorithm

To program and verify the AT89S8252 in the serial programming mode, the following sequence is recommended:

1. Power-up sequence:
Apply power between VCC and GND pins.
Set RST pin to "H".
If a crystal is not connected across pins XTAL1 and XTAL2, apply a 3 MHz to 24 MHz clock to XTAL1 pin and wait for at least 10 milliseconds.
2. Enable serial programming by sending the Programming Enable serial instruction to pin MOSI/P1.5. The frequency of the shift clock supplied at pin SCK/P1.7 needs to be less than the CPU clock at XTAL1 divided by 40.
3. The Code or Data array is programmed one byte at a time by supplying the address and data together with the appropriate Write instruction. The selected memory location is first automatically erased before new data is written. The write cycle is self-timed and typically takes less than 2.5 ms at 5V.
4. Any memory location can be verified by using the Read instruction which returns the content at the selected address at serial output MISO/P1.6.
5. At the end of a programming session, RST can be set low to commence normal operation.

Power-off sequence (if needed):

- Set XTAL1 to "L" (if a crystal is not used).
- Set RST to "L".
- Turn V_{CC} power off.

Serial Programming Instruction

The Instruction Set for Serial Programming follows a 3-byte protocol and is shown in the following table:

Instruction Set

Instruction	Input Format			Operation
	Byte 1	Byte 2	Byte 3	
Programming Enable	1010 1100	0101 0011	xxxx xxxx	Enable serial programming interface after RST goes high.
Chip Erase	1010 1100	xxxx x100	xxxx xxxx	Chip erase both 8K & 2K memory arrays.
Read Code Memory	aaaa a001	low addr	xxxx xxxx	Read data from Code memory array at the selected address. The 5 MSBs of the first byte are the high order address bits. The low order address bits are in the second byte. Data are available at pin MISO during the third byte.
Write Code Memory	aaaa a010	low addr	data in	Write data to Code memory location at selected address. The address bits are the 5 MSBs of the first byte together with the second byte.
Read Data Memory	00aa a101	low addr	xxxx xxxx	Read data from Data memory array at selected address. Data are available at pin MISO during the third byte.
Write Data Memory	00aa a110	low addr	data in	Write data to Data memory location at selected address.
Write Lock Bits	1010 1100	x x111	xxxx xxxx	Write lock bits. Set LB1, LB2 or LB3 = "0" to program lock bits.

Note: 1. DATA polling is used to indicate the end of a write cycle which typically takes less than 2.5 ms at 5V.

2. "aaaaa" = high order address.

3. "x" = don't care.



Flash and EEPROM Parallel Programming Modes

Mode	RST	PSEN	ALE/PROG	EA/V _{pp}	P2.6	P2.7	P3.6	P3.7	Data I/O P0.7:0	Address P2.5:0 P1.7:0
Serial Prog. Modes	H	h ⁽¹⁾	h ⁽²⁾	x						
Chip Erase	H	L	 (2)	12V	H	L	L	L	X	X
Write (10K bytes) Memory	H	L		12V	L	H	H	H	DIN	ADDR
Read (10K bytes) Memory	H	L	H	12V	L	L	H	H	DOUT	ADDR
Write Lock Bits:	H	L		12V	H	L	H	L	DIN	X
Bit - 1									P0.7 = 0	X
Bit - 2									P0.6 = 0	X
Bit - 3									P0.5 = 0	X
Read Lock Bits:	H	L	H	12V	H	H	L	L	DOUT	X
Bit - 1									@P0.2	X
Bit - 2									@P0.1	X
Bit - 3									@P0.0	X
Read Atmel Code	H	L	H	12V	L	L	L	L	DOUT	30H
Read Device Code	H	L	H	12V	L	L	L	L	DOUT	31H
Serial Prog. Enable	H	L	 (2)	12V	L	H	L	H	P0.0 = 0	X
Serial Prog. Disable	H	L	 (2)	12V	L	H	L	H	P0.0 = 1	X
Read Serial Prog. Fuse	H	L	H	12V	H	H	L	H	@P0.0	X

Notes: 1. "h" = weakly pulled "High" internally.
 2. Chip Erase and Serial Programming Fuse require a 10 ms PROG pulse. Chip Erase needs to be performed first before reprogramming any byte with a content other than FFH.

3. P3.4 is pulled Low during programming to indicate RDY/BSY.
 4. "X" = don't care

Figure 13. Programming the Flash/EEPROM Memory

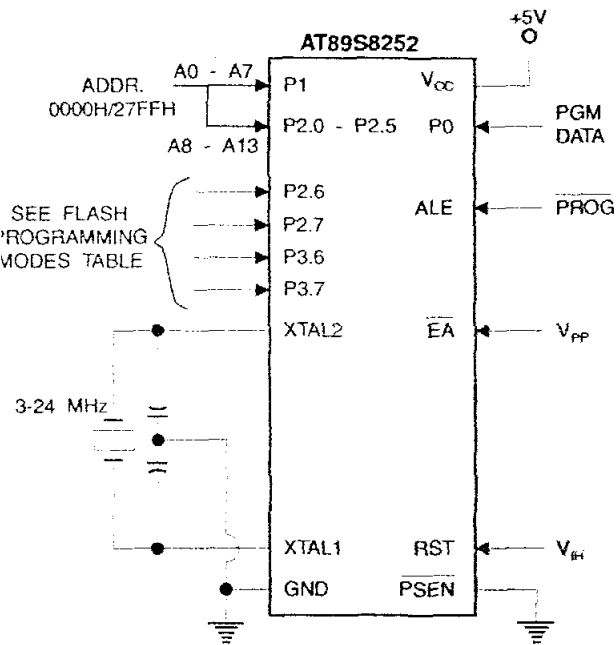


Figure 15. Flash/EEPROM Serial Downloading

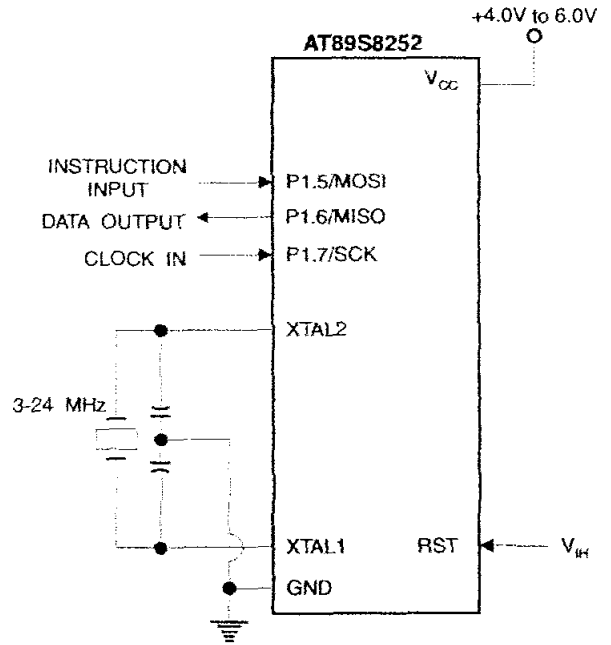
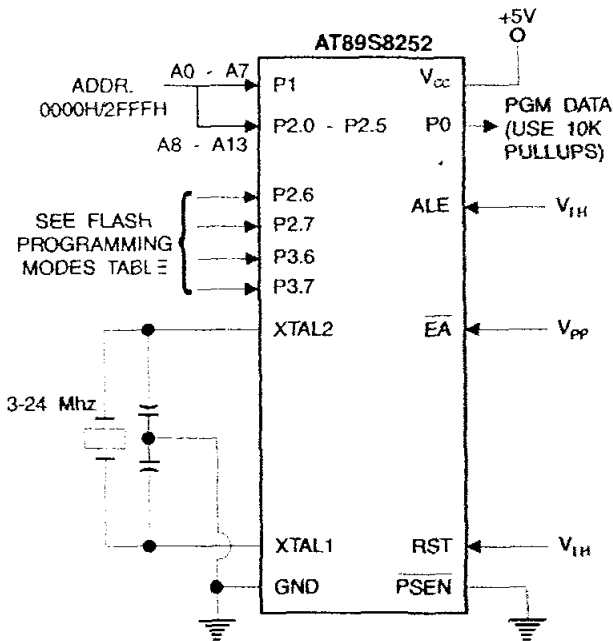


Figure 14. Verifying the Flash/EEPROM Memory



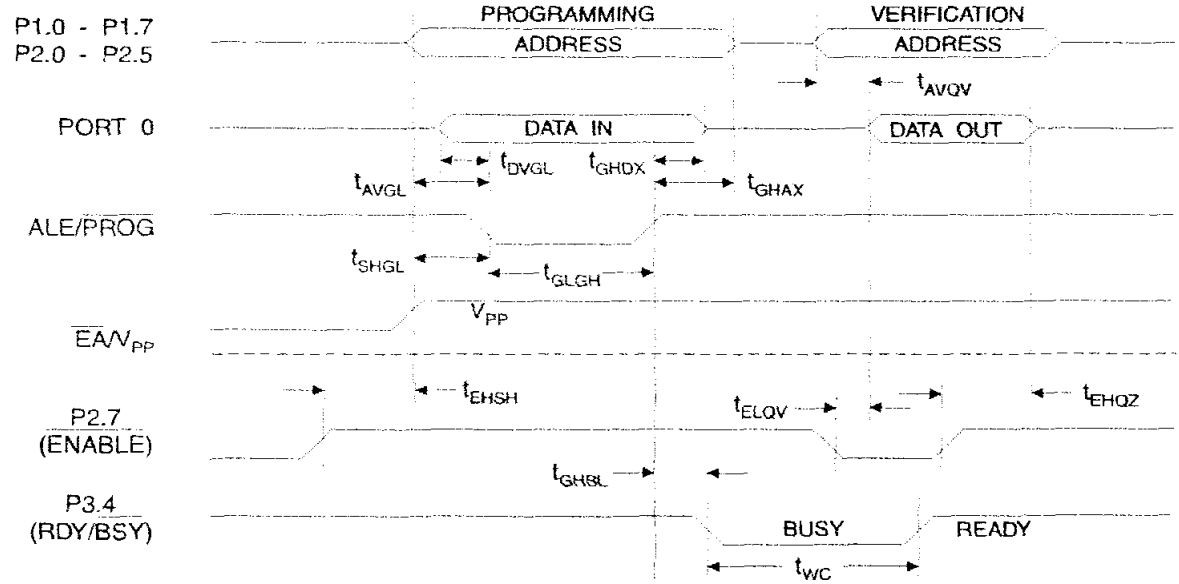


Flash Programming and Verification Characteristics – Parallel Mode

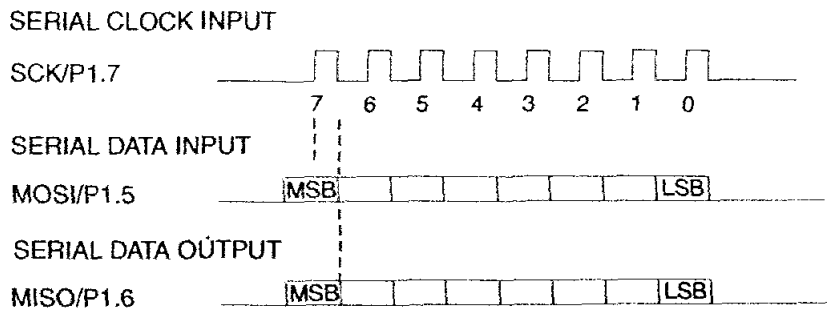
$T = 0^{\circ}\text{C}$ to 70°C , $V_{CC} = 5.0\text{V} \pm 10\%$

Symbol	Parameter	Min	Max	Units
V_P	Programming Enable Voltage	11.5	12.5	V
I_P	Programming Enable Current		1.0	mA
f_{CLCL}	Oscillator Frequency	3	24	MHz
t_{GL}	Address Setup to $\overline{\text{PROG}}$ Low	$48t_{CLCL}$		
t_{HAX}	Address Hold after $\overline{\text{PROG}}$	$48t_{CLCL}$		
t_{GL}	Data Setup to $\overline{\text{PROG}}$ Low	$48t_{CLCL}$		
t_{HDX}	Data Hold after $\overline{\text{PROG}}$	$48t_{CLCL}$		
t_{HSH}	P2.7 (ENABLE) High to V_{PP}	$48t_{CLCL}$		
t_{KGL}	V_{PP} Setup to $\overline{\text{PROG}}$ Low	10		μs
t_{LGH}	$\overline{\text{PROG}}$ Width	1	110	μs
t_{QV}	Address to Data Valid		$48t_{CLCL}$	
t_{QV}	$\overline{\text{ENABLE}}$ Low to Data Valid		$48t_{CLCL}$	
t_{QZ}	Data Float after $\overline{\text{ENABLE}}$	0	$48t_{CLCL}$	
t_{HBL}	$\overline{\text{PROG}}$ High to $\overline{\text{BUSY}}$ Low		1.0	μs
t_C	Byte Write Cycle Time		2.0	ms

Flash/EEPROM Programming and Verification Waveforms – Parallel Mode



Serial Downloading Waveforms





Absolute Maximum Ratings*

Operating Temperature.....	-55°C to +125°C
Storage Temperature.....	-65°C to +150°C
Voltage on Any Pin with Respect to Ground.....	-1.0V to +7.0V
Maximum Operating Voltage	6.6V
DC Output Current.....	15.0 mA

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC Characteristics

The values shown in this table are valid for $T_A = -40^{\circ}\text{C}$ to 85°C and $V_{CC} = 5.0\text{V} \pm 20\%$, unless otherwise noted.

Symbol	Parameter	Condition	Min	Max	Units
V_{IL}	Input Low-voltage	(Except $\overline{EA}$)	-0.5	$0.2 V_{CC} - 0.1$	V
V_{IL1}	Input Low-voltage ($\overline{EA}$)		-0.5	$0.2 V_{CC} - 0.3$	V
V_{IH}	Input High-voltage	(Except XTAL1, RST)	$0.2 V_{CC} + 0.9$	$V_{CC} + 0.5$	V
V_{IH1}	Input High-voltage	(XTAL1, RST)	$0.7 V_{CC}$	$V_{CC} + 0.5$	V
V_{OL}	Output Low-voltage ⁽¹⁾ (Ports 1,2,3)	$I_{OL} = 1.6 \text{ mA}$		0.5	V
V_{OL1}	Output Low-voltage ⁽¹⁾ (Port 0, ALE, $\overline{PSEN}$)	$I_{OL} = 3.2 \text{ mA}$		0.5	V
V_{OH}	Output High-voltage (Ports 1,2,3, ALE, $\overline{PSEN}$)	$I_{OH} = -60 \mu\text{A}$, $V_{CC} = 5\text{V} \pm 10\%$	2.4		V
		$I_{OH} = -25 \mu\text{A}$	$0.75 V_{CC}$		V
		$I_{OH} = -10 \mu\text{A}$	$0.9 V_{CC}$		V
V_{OH1}	Output High-voltage (Port 0 in External Bus Mode)	$I_{OH} = -800 \mu\text{A}$, $V_{CC} = 5\text{V} \pm 10\%$	2.4		V
		$I_{OH} = -300 \mu\text{A}$	$0.75 V_{CC}$		V
		$I_{OH} = -80 \mu\text{A}$	$0.9 V_{CC}$		V
I_L	Logical 0 Input Current (Ports 1,2,3)	$V_{IN} = 0.45\text{V}$		-50	μA
I_{TL}	Logical 1 to 0 Transition Current (Ports 1,2,3)	$V_{IN} = 2\text{V}$, $V_{CC} = 5\text{V} \pm 10\%$		-650	μA
I_{LI}	Input Leakage Current (Port 0, $\overline{EA}$)	$0.45 < V_{IN} < V_{CC}$		± 10	μA
R_{RST}	Reset Pull-down Resistor		50	300	$\text{K}\Omega$
C_{IO}	Pin Capacitance	Test Freq. = 1 MHz, $T_A = 25^{\circ}\text{C}$		10	pF
I_{CC}	Power Supply Current	Active Mode, 12 MHz		25	mA
		Idle Mode, 12 MHz		6.5	mA
	Power-down Mode ⁽²⁾	$V_{CC} = 6\text{V}$		100	μA
		$V_{CC} = 3\text{V}$		40	μA

Notes: 1. Under steady state (non-transient) conditions, I_{OL} must be externally limited as follows:
Maximum I_{OL} per port pin: 10 mA
Maximum I_{OL} per 8-bit port:
Port 0: 26 mA
Ports 1, 2, 3: 15 mA

Maximum total I_{OL} for all output pins: 71 mA
If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.
2. Minimum V_{CC} for Power-down is 2V

Characteristics

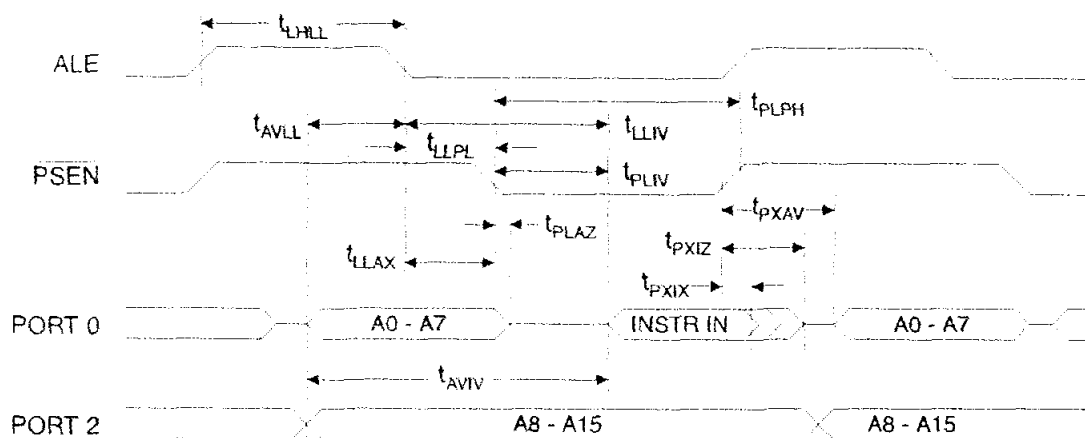
Under operating conditions, load capacitance for Port 0, ALE/PROG, and PSEN = 100 pF; load capacitance for all other outputs = 80 pF.

External Program and Data Memory Characteristics

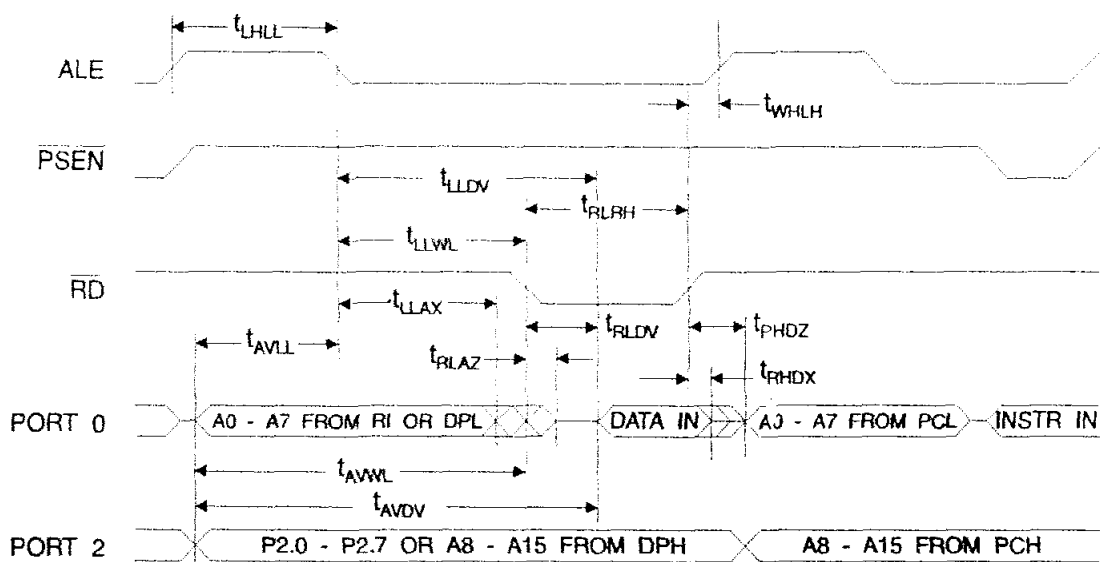
Symbol	Parameter	Variable Oscillator		Units
		Min	Max	
t_{CLCL}	Oscillator Frequency	0	24	MHz
t_{HLL}	ALE Pulse Width	$2t_{CLCL} - 40$		ns
t_{VLL}	Address Valid to ALE Low	$t_{CLCL} - 13$		ns
t_{LAX}	Address Hold after ALE Low	$t_{CLCL} - 20$		ns
t_{LV}	ALE Low to Valid Instruction In		$4t_{CLCL} - 65$	ns
t_{LPL}	ALE Low to PSEN Low	$t_{CLCL} - 13$		ns
t_{LPH}	PSEN Pulse Width	$3t_{CLCL} - 20$		ns
t_{LV}	PSEN Low to Valid Instruction In		$3t_{CLCL} - 45$	ns
t_{XIX}	Input Instruction Hold after PSEN	0		ns
t_{XIZ}	Input Instruction Float after PSEN		$t_{CLCL} - 10$	ns
t_{XAV}	PSEN to Address Valid	$t_{CLCL} - 8$		ns
t_{XIV}	Address to Valid Instruction In		$5t_{CLCL} - 55$	ns
t_{LAZ}	PSEN Low to Address Float		10	ns
t_{RLRH}	RD Pulse Width	$6t_{CLCL} - 100$		ns
t_{VLWH}	WR Pulse Width	$6t_{CLCL} - 100$		ns
t_{RLDV}	RD Low to Valid Data In		$5t_{CLCL} - 90$	ns
t_{RHDZ}	Data Hold after RD	0		ns
t_{RHDZ}	Data Float after RD		$2t_{CLCL} - 28$	ns
t_{LDV}	ALE Low to Valid Data In		$8t_{CLCL} - 150$	ns
t_{VDV}	Address to Valid Data In		$9t_{CLCL} - 165$	ns
t_{LWL}	ALE Low to RD or WR Low	$3t_{CLCL} - 50$	$3t_{CLCL} + 50$	ns
t_{VWL}	Address to RD or WR Low	$4t_{CLCL} - 75$		ns
t_{QVWX}	Data Valid to WR Transition	$t_{CLCL} - 20$		ns
t_{QVWH}	Data Valid to WR High	$7t_{CLCL} - 120$		ns
t_{WHQX}	Data Hold after WR	$t_{CLCL} - 20$		ns
t_{RLAZ}	RD Low to Address Float		0	ns
t_{WLH}	RD or WR High to ALE High	$t_{CLCL} - 20$	$t_{CLCL} + 25$	ns



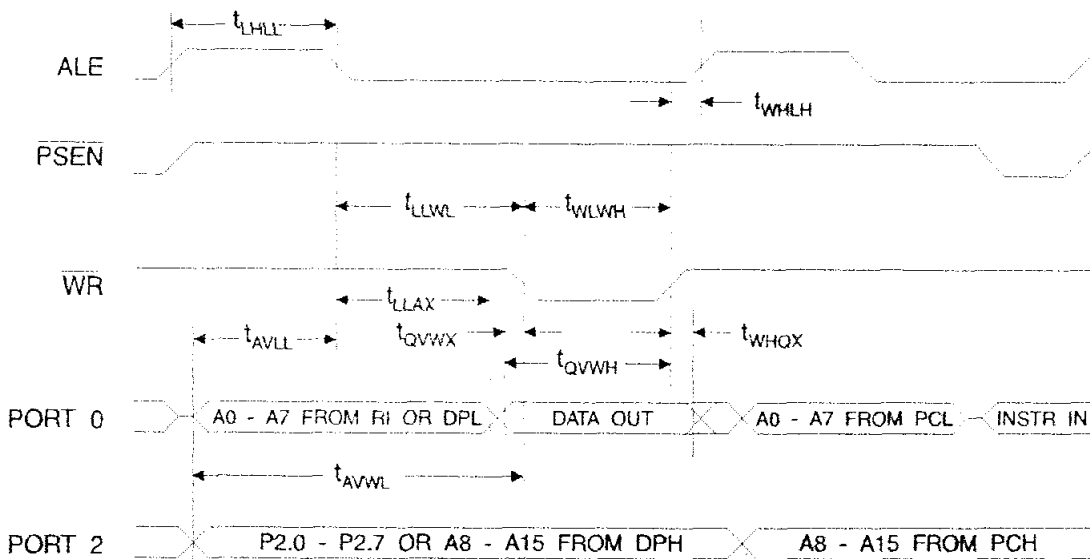
External Program Memory Read Cycle



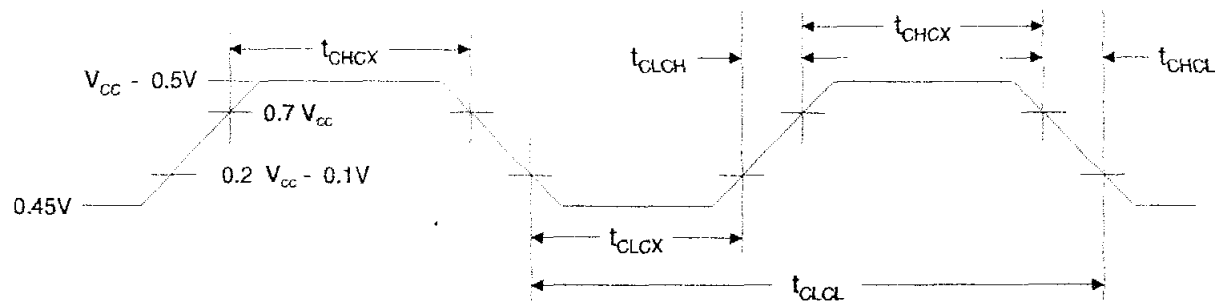
External Data Memory Read Cycle



External Data Memory Write Cycle



External Clock Drive Waveforms



External Clock Drive

Symbol	Parameter	$V_{CC} = 4.0V \text{ to } 6.0V$		Units
		Min	Max	
f_{CLCL}	Oscillator Frequency	0	24	MHz
t_{CLCL}	Clock Period	41.6		ns
t_{CHCX}	High Time	15		ns
t_{CLCX}	Low Time	15		ns
t_{CLCH}	Rise Time		20	ns
t_{CHCL}	Fall Time		20	ns

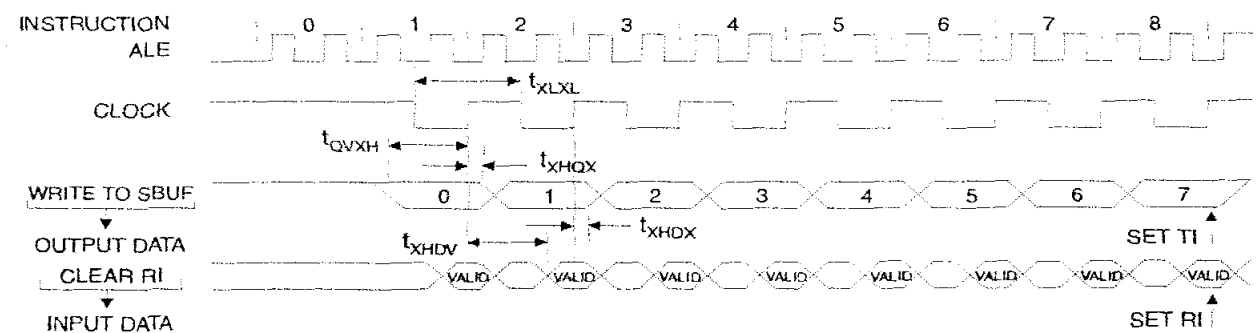


Serial Port Timing: Shift Register Mode Test Conditions

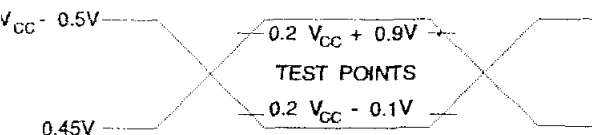
The values in this table are valid for $V_{CC} = 4.0V$ to $6V$ and Load Capacitance = 80 pF .

Symbol	Parameter	Variable Oscillator		Units
		Min	Max	
t_{CLK}	Serial Port Clock Cycle Time	$12t_{CLCL}$		μs
t_{QVXH}	Output Data Setup to Clock Rising Edge	$10t_{CLCL} - 133$		ns
t_{HQX}	Output Data Hold after Clock Rising Edge	$2t_{CLCL} - 117$		ns
t_{HDX}	Input Data Hold after Clock Rising Edge	0		ns
t_{HDV}	Clock Rising Edge to Input Data Valid		$10t_{CLCL} - 133$	ns

Shift Register Mode Timing Waveforms

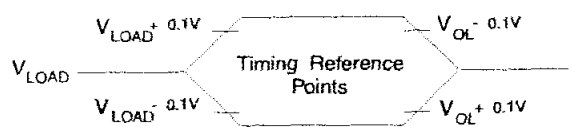


AC Testing Input/Output Waveforms⁽¹⁾



Notes: 1. AC Inputs during testing are driven at $V_{CC} - 0.5V$ for a logic 1 and $0.45V$ for a logic 0. Timing measurements are made at V_{IH} min. for a logic 1 and V_{IL} max. for a logic 0.

Float Waveforms⁽¹⁾



Notes: 1. For timing purposes, a port pin is no longer floating when a 100 mV change from load voltage occurs. A port pin begins to float when a 100 mV change from the loaded V_{OH}/V_{OL} level occurs.

LAMPIRAN E

LM741 Operational Amplifier

General Description

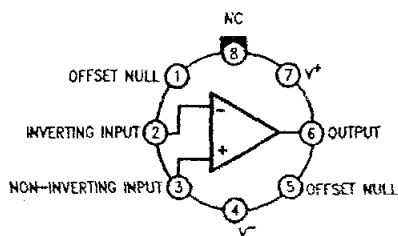
The LM741 series are general purpose operational amplifiers which feature improved performance over industry standards like the LM709. They are direct, plug-in replacements for the 709C, LM201, MC1439 and 748 in most applications.

The amplifiers offer many features which make their application nearly foolproof: overload protection on the input and output, no latch-up when the common mode range is exceeded, as well as freedom from oscillations.

The LM741C is identical to the LM741/LM741A except that the LM741C has their performance guaranteed over a 0°C to +70°C temperature range, instead of -55°C to +125°C.

Connection Diagrams

Metal Can Package

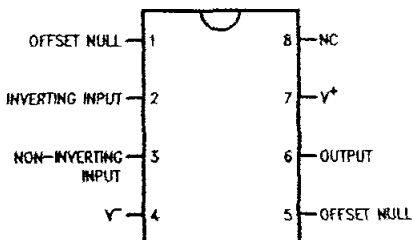


DS009341-2

Note 1: LM741H is available per JM38510/10101

Order Number LM741H, LM741H/883 (Note 1),
LM741AH/883 or LM741CH
See NS Package Number H08C

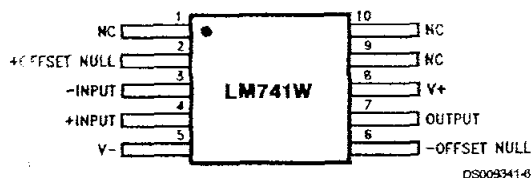
Dual-In-Line or S.O. Package



DS009341-3

Order Number LM741J, LM741J/883, LM741CN
See NS Package Number J08A, M08A or N08E

Ceramic Flatpak

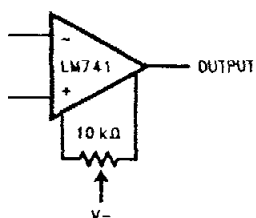


DS009341-6

Order Number LM741W/883
See NS Package Number W10A

Typical Application

Offset Nulling Circuit



DS009341-7

Absolute Maximum Ratings (Note 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

(Note 7)

	LM741A	LM741	LM741C
Supply Voltage	±22V	±22V	±18V
Power Dissipation (Note 3)	500 mW	500 mW	500 mW
Differential Input Voltage	±30V	±30V	±30V
Input Voltage (Note 4)	±15V	±15V	±15V
Output Short Circuit Duration	Continuous	Continuous	Continuous
Operating Temperature Range	-55°C to +125°C	-55°C to +125°C	0°C to +70°C
Storage Temperature Range	-65°C to +150°C	-65°C to +150°C	-65°C to +150°C
Junction Temperature	150°C	150°C	100°C
Soldering Information			
N-Package (10 seconds)	260°C	260°C	260°C
J- or H-Package (10 seconds)	300°C	300°C	300°C
M-Package			
Vapor Phase (60 seconds)	215°C	215°C	215°C
Infrared (15 seconds)	215°C	215°C	215°C

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

ESD Tolerance (Note 8)	400V	400V	400V
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Electrical Characteristics (Note 5)

Parameter	Conditions	LM741A			LM741			LM741C			Units
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Input Offset Voltage	$T_A = 25^\circ\text{C}$										mV
	$R_S \leq 10\text{ k}\Omega$					1.0	5.0		2.0	6.0	mV
	$R_S \leq 50\Omega$		0.8	3.0							mV
	$T_{AMIN} \leq T_A \leq T_{AMAX}$										mV
Average Input Offset Voltage Drift	$R_S \leq 50\Omega$			4.0							mV
	$R_S \leq 10\text{ k}\Omega$						6.0			7.5	mV
Average Input Offset Voltage Drift				15							$\mu\text{V}/^\circ\text{C}$
Input Offset Voltage Adjustment Range	$T_A = 25^\circ\text{C}, V_S = \pm 20\text{V}$	±10				±15			±15		mV
Input Offset Current	$T_A = 25^\circ\text{C}$		3.0	30		20	200		20	200	nA
	$T_{AMIN} \leq T_A \leq T_{AMAX}$			70		85	500			300	nA
Average Input Offset Current Drift				0.5							$\text{nA}/^\circ\text{C}$
Input Bias Current	$T_A = 25^\circ\text{C}$		30	80		80	500		80	500	nA
	$T_{AMIN} \leq T_A \leq T_{AMAX}$			0.210			1.5			0.8	μA
Input Resistance	$T_A = 25^\circ\text{C}, V_S = \pm 20\text{V}$	1.0	6.0		0.3	2.0		0.3	2.0		$\text{M}\Omega$
	$T_{AMIN} \leq T_A \leq T_{AMAX}, V_S = \pm 20\text{V}$	0.5									$\text{M}\Omega$
Input Voltage Range	$T_A = 25^\circ\text{C}$							±12	±13		V
	$T_{AMIN} \leq T_A \leq T_{AMAX}$				±12	±13					V

Electrical Characteristics (Note 5) (Continued)

Parameter	Conditions	LM741A			LM741			LM741C			Units
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Large Signal Voltage Gain	$T_A = 25^\circ\text{C}$, $R_L \geq 2\text{ k}\Omega$										
	$V_S = \pm 20\text{V}$, $V_O = \pm 15\text{V}$	50									V/mV
	$V_S = \pm 15\text{V}$, $V_O = \pm 10\text{V}$				50	200		20	200		V/mV
	$T_{A\text{MIN}} \leq T_A \leq T_{A\text{MAX}}$, $R_L \geq 2\text{ k}\Omega$, $V_S = \pm 20\text{V}$, $V_O = \pm 15\text{V}$	32									V/mV
	$V_S = \pm 15\text{V}$, $V_O = \pm 10\text{V}$				25			15			V/mV
Output Voltage Swing	$V_S = \pm 5\text{V}$, $V_O = \pm 2\text{V}$	10									V/mV
	$V_S = \pm 20\text{V}$										
	$R_L \geq 10\text{ k}\Omega$	± 16									V
	$R_L \geq 2\text{ k}\Omega$	± 15									V
	$V_S = \pm 15\text{V}$										
Output Short Circuit Current	$R_L \geq 10\text{ k}\Omega$				± 12	± 14		± 12	± 14		V
	$R_L \geq 2\text{ k}\Omega$				± 10	± 13		± 10	± 13		V
	$T_A = 25^\circ\text{C}$	10	25	35		25			25		mA
	$T_{A\text{MIN}} \leq T_A \leq T_{A\text{MAX}}$	10		40							mA
Common-Mode Rejection Ratio	$T_{A\text{MIN}} \leq T_A \leq T_{A\text{MAX}}$										
	$R_S \leq 10\text{ k}\Omega$, $V_{\text{CM}} = \pm 12\text{V}$				70	90		70	90		dB
	$R_S \leq 50\Omega$, $V_{\text{CM}} = \pm 12\text{V}$	80	95								dB
Supply Voltage Rejection Ratio	$T_{A\text{MIN}} \leq T_A \leq T_{A\text{MAX}}$, $V_S = \pm 20\text{V}$ to $V_S = \pm 5\text{V}$										
	$R_S \leq 50\Omega$	86	96								dB
	$R_S \leq 10\text{ k}\Omega$				77	96		77	96		dB
Transient Response	$T_A = 25^\circ\text{C}$, Unity Gain										
	Rise Time		0.25	0.8		0.3			0.3		μs
	Overshoot		6.0	20		5			5		%
Bandwidth (Note 6)	$T_A = 25^\circ\text{C}$	0.437	1.5								MHz
Slew Rate	$T_A = 25^\circ\text{C}$, Unity Gain	0.3	0.7			0.5			0.5		V/ μs
Supply Current	$T_A = 25^\circ\text{C}$					1.7	2.8		1.7	2.8	mA
Power Consumption	$T_A = 25^\circ\text{C}$										
	$V_S = \pm 20\text{V}$		80	150							mW
	$V_S = \pm 15\text{V}$					50	85		50	85	mW
	$V_S = \pm 20\text{V}$										
	$T_A = T_{A\text{MIN}}$			165							mW
LM741A	$T_A = T_{A\text{MAX}}$			135							mW
LM741	$V_S = \pm 15\text{V}$										
	$T_A = T_{A\text{MIN}}$					60	100				mW
	$T_A = T_{A\text{MAX}}$					45	75				mW

Note 2: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits.

Electrical Characteristics (Note 5) (Continued)

Note 3: For operation at elevated temperatures, these devices must be derated based on thermal resistance, and T_j max. (listed under "Absolute Maximum Ratings"). $T_j = T_A + (\theta_{JA} P_D)$.

Thermal Resistance	Cerdip (J)	DIP (N)	HO8 (H)	SO-8 (M)
θ_{JA} (Junction to Ambient)	100°C/W	100°C/W	170°C/W	195°C/W
θ_{JC} (Junction to Case)	N/A	N/A	25°C/W	N/A

Note 4: For supply voltages less than $\pm 15V$, the absolute maximum input voltage is equal to the supply voltage.

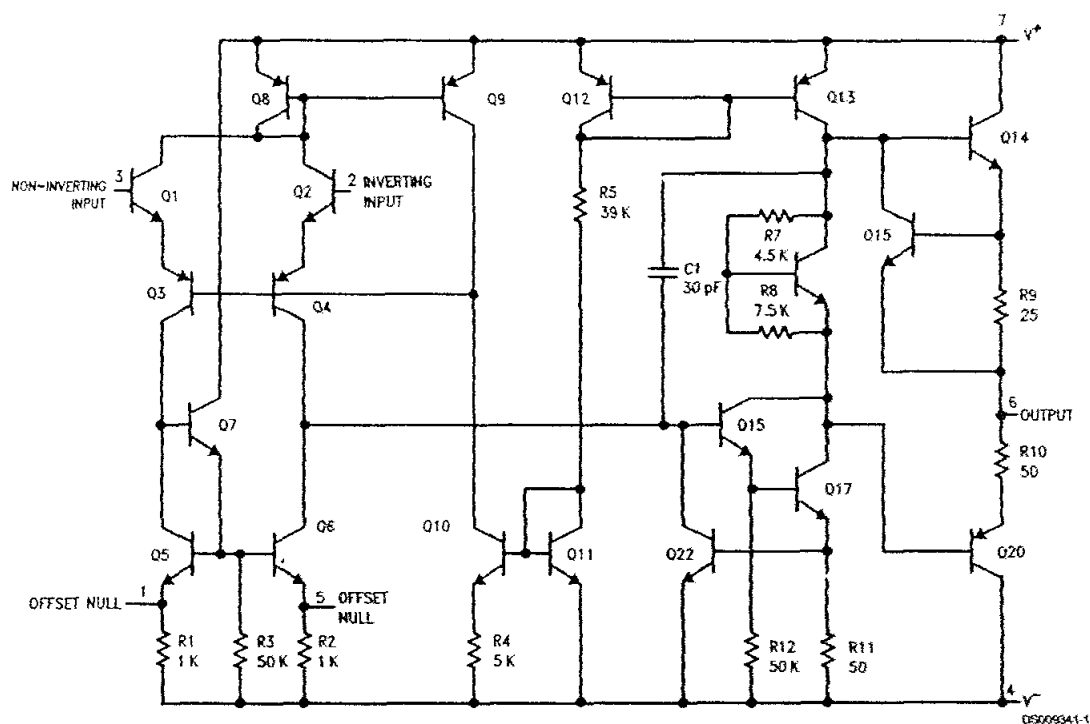
Note 5: Unless otherwise specified, these specifications apply for $V_S = \pm 15V$, $-55^\circ C \leq T_A \leq +125^\circ C$ (LM741/LM741A). For the LM741C/LM741E, these specifications are limited to $0^\circ C \leq T_A \leq +70^\circ C$.

Note 6: Calculated value from: BW (MHz) = $0.35/\text{Rise Time}(\mu s)$.

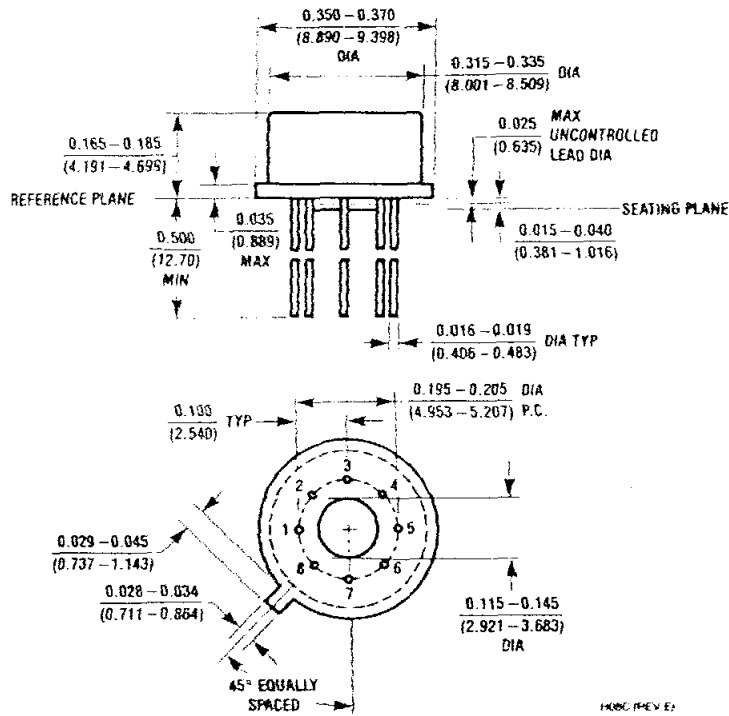
Note 7: For military specifications see RETS741X for LM741 and RETS741AX for LM741A.

Note 8: Human body model, 1.5 k Ω in series with 100 pF.

Schematic Diagram

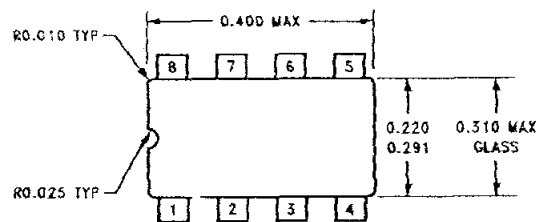


Physical Dimensions inches (millimeters) unless otherwise noted



Metal Can Package (H)

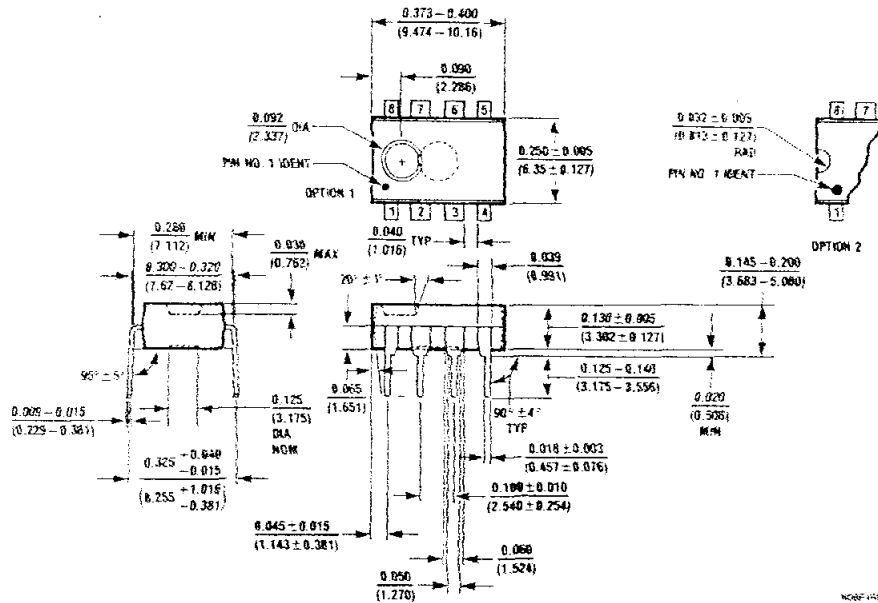
Order Number LM741H, LM741H/883, LM741AH/883, LM741AH-MIL or LM741CH
NS Package Number H08C



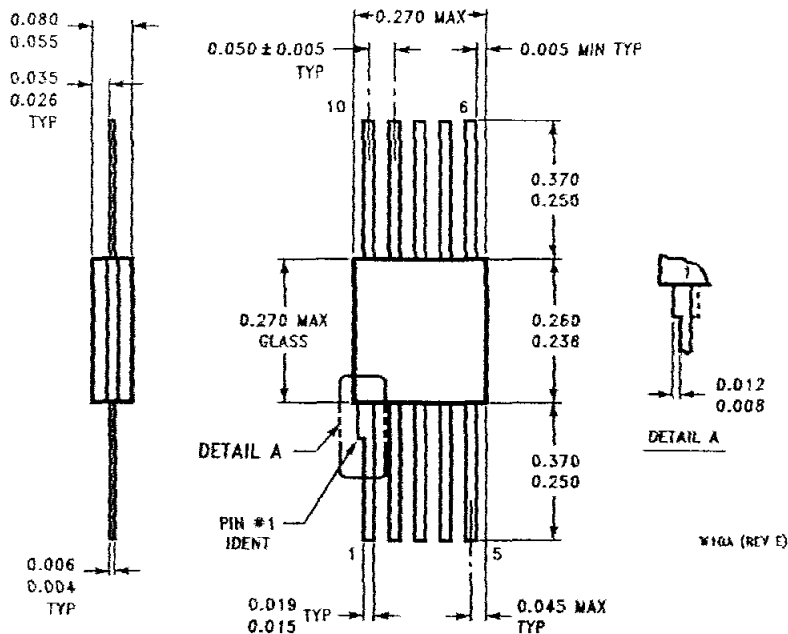
Ceramic Dual-In-Line Package (J)

Order Number LM741J/883
NS Package Number J08A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Dual-In-Line Package (N)
Order Number LM741CN
NS Package Number N08E



10-Lead Ceramic Flatpak (W)
Order Number LM741W/883, LM741WG-MPR or LM741WG/883
NS Package Number W10A

LAMPIRAN F

LM78XX Series Voltage Regulators

General Description

The LM78XX series of three terminal regulators is available with several fixed output voltages making them useful in a wide range of applications. One of these is local on card regulation, eliminating the distribution problems associated with single point regulation. The voltages available allow these regulators to be used in logic systems, instrumentation, HiFi, and other solid state electronic equipment. Although designed primarily as fixed voltage regulators these devices can be used with external components to obtain adjustable voltages and currents.

The LM78XX series is available in an aluminum TO-3 package which will allow over 1.0A load current if adequate heat sinking is provided. Current limiting is included to limit the peak output current to a safe value. Safe area protection for the output transistor is provided to limit internal power dissipation. If internal power dissipation becomes too high for the heat sinking provided, the thermal shutdown circuit takes over preventing the IC from overheating.

Considerable effort was expended to make the LM78XX series of regulators easy to use and minimize the number

of external components. It is not necessary to bypass the output, although this does improve transient response. Input bypassing is needed only if the regulator is located far from the filter capacitor of the power supply.

For output voltage other than 5V, 12V and 15V the LM117 series provides an output voltage range from 1.2V to 57V.

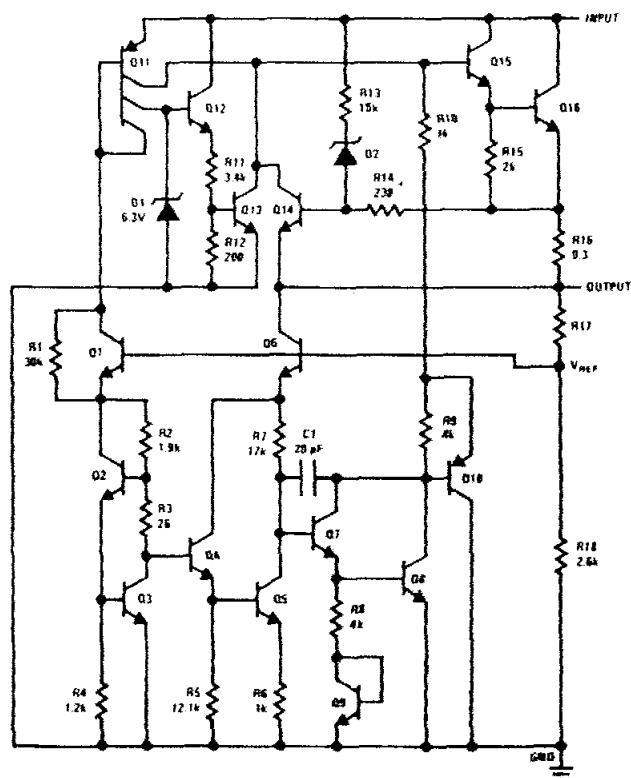
Features

- Output current in excess of 1A
- Internal thermal overload protection
- No external components required
- Output transistor safe area protection
- Internal short circuit current limit
- Available in the aluminum TO-3 package

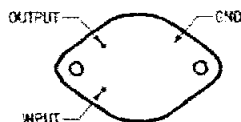
Voltage Range

LM7805C	5V
LM7812C	12V
LM7815C	15V

Schematic and Connection Diagrams



**Metal Can Package
TO-3 (K)
Aluminum**

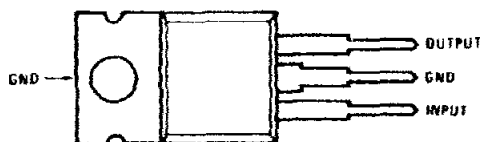


TL/H/7746-2

Bottom View

**Order Number LM7805CK,
LM7812CK or LM7815CK
See NS Package Number KC02A**

**Plastic Package
TO-220 (T)**



TL/H/7746-3

Top View

**Order Number LM7805CT,
LM7812CT or LM7815CT
See NS Package Number T03B**

TL/H/7746-1

Absolute Maximum Ratings

For military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Output Voltage ($V_O = 5V, 12V$ and $15V$) 35V
 Total Power Dissipation (Note 1) Internally Limited
 Operating Temperature Range (T_A) 0°C to $+70^\circ\text{C}$

Maximum Junction Temperature

(K Package) 150°C

(T Package) 150°C

Storage Temperature Range -65°C to $+150^\circ\text{C}$

Lead Temperature (Soldering, 10 sec.)

TO-3 Package K 300°C

TO-220 Package T 230°C

Electrical Characteristics LM78XXC (Note 2) $0^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$ unless otherwise noted.

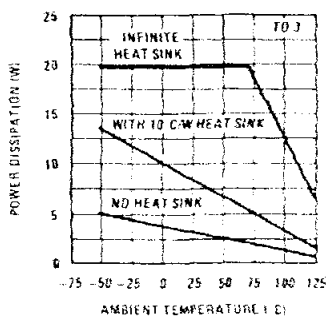
Output Voltage			5V			12V			15V			Units
Input Voltage (unless otherwise noted)			10V			19V			23V			
Parameter	Conditions		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Output Voltage	$T_J = 25^{\circ}\text{C}, 5\text{ mA} \leq I_O \leq 1\text{ A}$		4.8	5	5.2	11.5	12	12.5	14.4	15	15.6	V
	$P_D \leq 15\text{ W}, 5\text{ mA} \leq I_O \leq 1\text{ A}$		4.75		5.25	11.4		12.6	14.25		15.75	V
	$V_{\text{MIN}} \leq V_{\text{IN}} \leq V_{\text{MAX}}$		(7.5 $\leq V_{\text{IN}} \leq 20$)			(14.5 $\leq V_{\text{IN}} \leq 27$)			(17.5 $\leq V_{\text{IN}} \leq 30$)			V
Line Regulation	$I_O = 500\text{ mA}$	$T_J = 25^{\circ}\text{C}$	3 50			4 120			4 150			mV
		ΔV_{IN}	(7 $\leq V_{\text{IN}} \leq 25$)			(14.5 $\leq V_{\text{IN}} \leq 30$)			(17.5 $\leq V_{\text{IN}} \leq 30$)			V
		$0^{\circ}\text{C} \leq T_J \leq +125^{\circ}\text{C}$	50			120			150			mV
	$I_O \leq 1\text{ A}$	ΔV_{IN}	(8 $\leq V_{\text{IN}} \leq 20$)			(15 $\leq V_{\text{IN}} \leq 27$)			(18.5 $\leq V_{\text{IN}} \leq 30$)			V
		$T_J = 25^{\circ}\text{C}$	50			120			150			mV
		ΔV_{IN}	(7.5 $\leq V_{\text{IN}} \leq 20$)			(14.6 $\leq V_{\text{IN}} \leq 27$)			(17.7 $\leq V_{\text{IN}} \leq 30$)			V
Load Regulation	$T_J = 25^{\circ}\text{C}$	$5\text{ mA} \leq I_O \leq 1.5\text{ A}$	10 50			12 120			12 150			mV
		$250\text{ mA} \leq I_O \leq 750\text{ mA}$	25			60			75			mV
	$5\text{ mA} \leq I_O \leq 1\text{ A}, 0^{\circ}\text{C} \leq T_J \leq +125^{\circ}\text{C}$		50			120			150			mV
Quiescent Current	$I_O \leq 1\text{ A}$	$T_J = 25^{\circ}\text{C}$	8			8			8			mA
		$0^{\circ}\text{C} \leq T_J \leq +125^{\circ}\text{C}$	8.5			8.5			8.5			mA
Quiescent Current Change	$5\text{ mA} \leq I_O \leq 1\text{ A}$		0.5			0.5			0.5			mA
	$T_J = 25^{\circ}\text{C}, I_O \leq 1\text{ A}$		1.0			1.0			1.0			mA
	$V_{\text{MIN}} \leq V_{\text{IN}} \leq V_{\text{MAX}}$		(7.5 $\leq V_{\text{IN}} \leq 20$)			(14.8 $\leq V_{\text{IN}} \leq 27$)			(17.9 $\leq V_{\text{IN}} \leq 30$)			V
	$I_O \leq 500\text{ mA}, 0^{\circ}\text{C} \leq T_J \leq +125^{\circ}\text{C}$		1.0			1.0			1.0			mA
	$V_{\text{MIN}} \leq V_{\text{IN}} \leq V_{\text{MAX}}$		(7 $\leq V_{\text{IN}} \leq 25$)			(14.5 $\leq V_{\text{IN}} \leq 30$)			(17.5 $\leq V_{\text{IN}} \leq 30$)			V
Output Noise Voltage	$T_A = 25^{\circ}\text{C}, 10\text{ Hz} \leq f \leq 100\text{ kHz}$		40			75			90			μV
Ripple Rejection	$f = 120\text{ Hz} \begin{cases} I_O \leq 1\text{ A}, T_J = 25^{\circ}\text{C} \text{ or} \\ I_O \leq 500\text{ mA} \\ 0^{\circ}\text{C} \leq T_J \leq +125^{\circ}\text{C} \end{cases}$		62	80		55	72		54	70		dB
			62			55			54			dB
	$V_{\text{MIN}} \leq V_{\text{IN}} \leq V_{\text{MAX}}$		(8 $\leq V_{\text{IN}} \leq 18$)			(15 $\leq V_{\text{IN}} \leq 25$)			(18.5 $\leq V_{\text{IN}} \leq 28.5$)			V
Dropout Voltage	$T_J = 25^{\circ}\text{C}, I_{\text{OUT}} = 1\text{ A}$		2.0			2.0			2.0			V
Output Resistance	$f = 1\text{ kHz}$		8			18			19			m Ω
Short-Circuit Current	$T_J = 25^{\circ}\text{C}$		2.1			1.5			1.2			A
Peak Output Current	$T_J = 25^{\circ}\text{C}$		2.4			2.4			2.4			A
Average TC of V_{OUT}	$0^{\circ}\text{C} \leq T_J \leq +125^{\circ}\text{C}, I_O = 5\text{ mA}$		0.6			1.5			1.8			mV/ $^{\circ}\text{C}$
Input Voltage Required to Maintain Line Regulation	$T_J = 25^{\circ}\text{C}, I_O \leq 1\text{ A}$		7.5			14.6			17.7			V

1: Thermal resistance of the TO-3 package (K, KC) is typically 4°C/W junction to case and 35°C/W case to ambient. Thermal resistance of the TO-220 package (T) is typically 4°C/W junction to case and 50°C/W case to ambient.

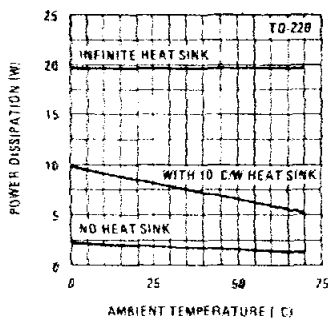
2: All characteristics are measured with capacitor across the input of $0.22\text{ }\mu\text{F}$, and a capacitor across the output of $0.1\text{ }\mu\text{F}$. All characteristics except noise and ripple rejection ratio are measured using pulse techniques ($t_w \leq 10\text{ ms}$, duty cycle $\leq 5\%$). Output voltage changes due to changes in internal temperature must be taken into account separately.

Typical Performance Characteristics

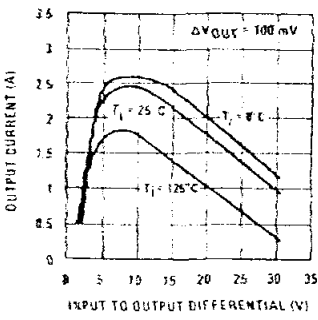
Maximum Average Power Dissipation



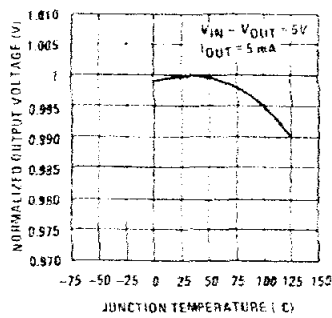
Maximum Average Power Dissipation



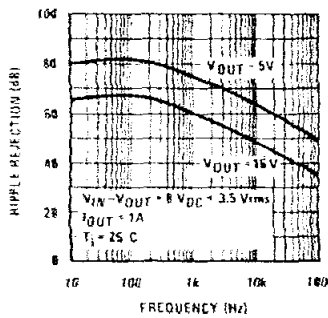
Peak Output Current



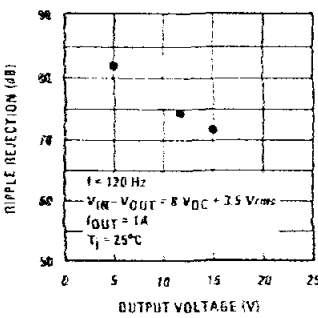
Output Voltage (Normalized to 1V at $T_J = 25^\circ\text{C}$)



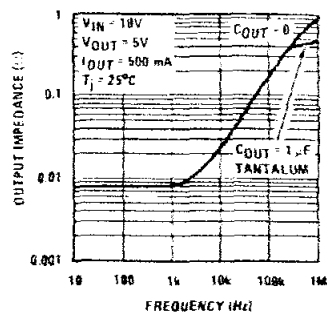
Ripple Rejection



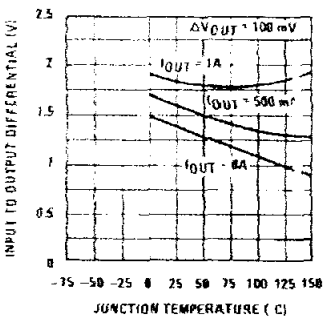
Ripple Rejection



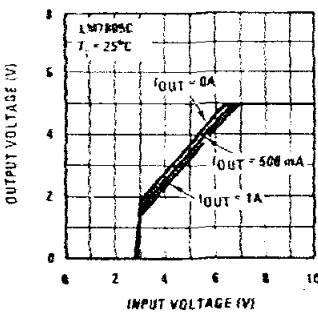
Output Impedance



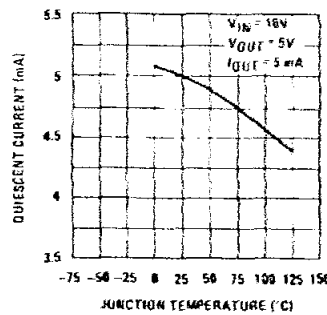
Dropout Voltage



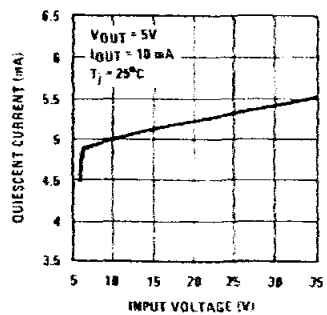
Dropout Characteristics



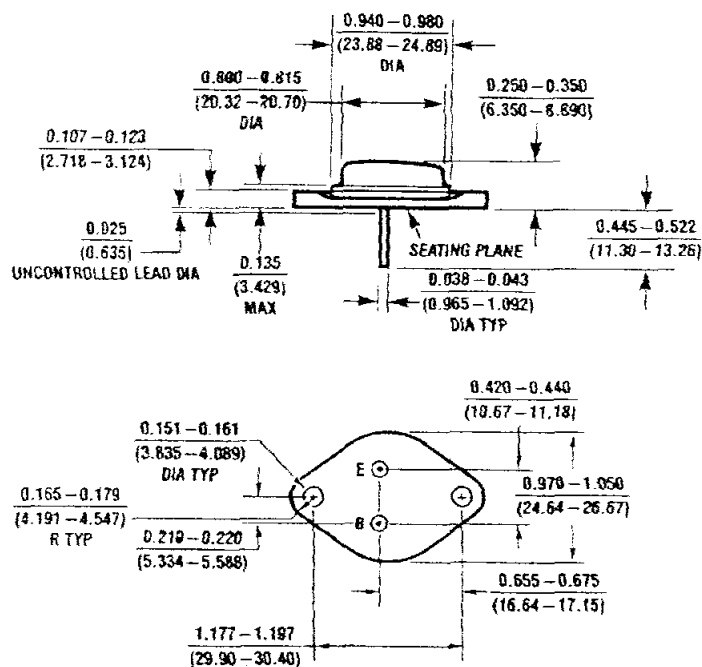
Quiescent Current



Quiescent Current



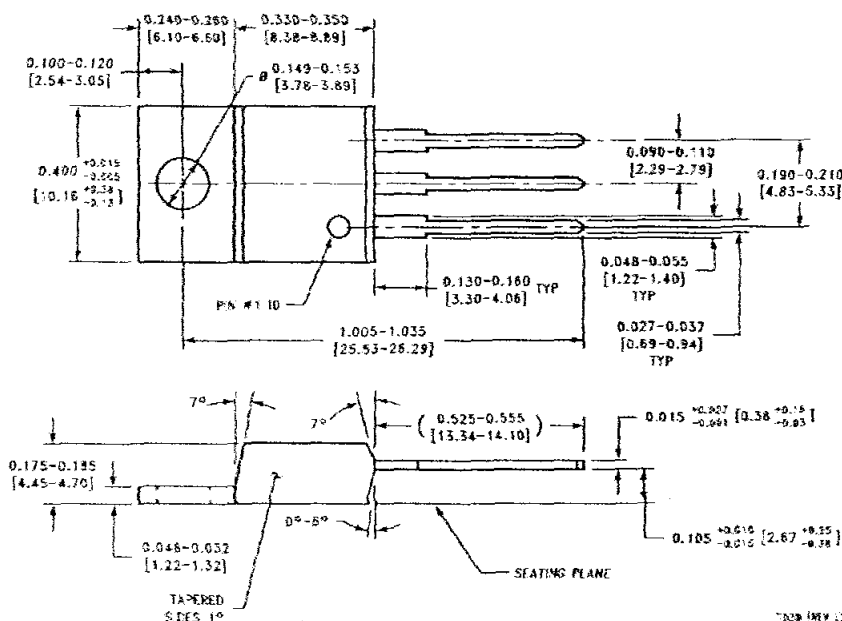
Physical Dimensions inches (millimeters)



KC02A (REV C)

Aluminum Metal Can Package (KC)
Order Number LM7805CK, LM7812CK or LM7815CK
NS Package Number KC02A

Physical Dimensions inches (millimeters) (Continued)



TO-220 Package (T)

Order Number LM7805CT, LM7812CT or LM7815CT
NS Package Number T03B

T03B (REV 12)

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National Semiconductor Corporation
1111 West Bardin Road
Arlington, TX 76017
Tel: 1(800) 272-9959
Fax: 1(800) 737-7018

National Semiconductor Europe
Fax: (+49) 0-180-530 85 86
Email: cnjwge@tntnm2.nsc.com
Deutsch Tel: (+49) 0-180-530 85 85
English Tel: (+49) 0-180-532 78 32
Français Tel: (+49) 0-180-532 93 58
Italiano Tel: (+49) 0-180-534 16 80

National Semiconductor Hong Kong Ltd.
13th Floor, Straits Block,
Ocean Centre, 5 Canton Rd.
Tsimshatsui, Kowloon
Hong Kong
Tel: (852) 2737-1600
Fax: (852) 2736-9950

National Semiconductor Japan Ltd.
Tel: 81-043-299-2309
Fax: 81-043-299-2408

BIODATA



Nama : Chornelius Ariesta Abdi

NRP : 5103000066

Tempat, Tgl. Lahir : Surabaya, 07-04-1982

Agama : Kristen

Alamat Rumah : Jl. Bendul Merisi Permai E/4
Surabaya.

Riwayat Pendidikan :

- Tahun 1994 Lulus SDK. Kartini, Surabaya.
- Tahun 1997 Lulus SMPK Santo Carolus, Surabaya.
- Tahun 2000 Lulus SMK Kristen Petra, Surabaya.

